

Mitsubishi Electric Programmable Controllers



MELSEC PROCESS CONTROL/REDUNDANT SYSTEM



MELSEC process control is a flexible, highly reliable platform with advanced functionality designed to cost-effectively meet the needs of a wide range of industries.

Reduce costs

Mitsubishi Electric automation products give users the flexibility to configure their systems according to their needs, unlike a distributed control system (DCS), which is developed by the vender from the initial design phase. This can greatly reduce initial and running costs.

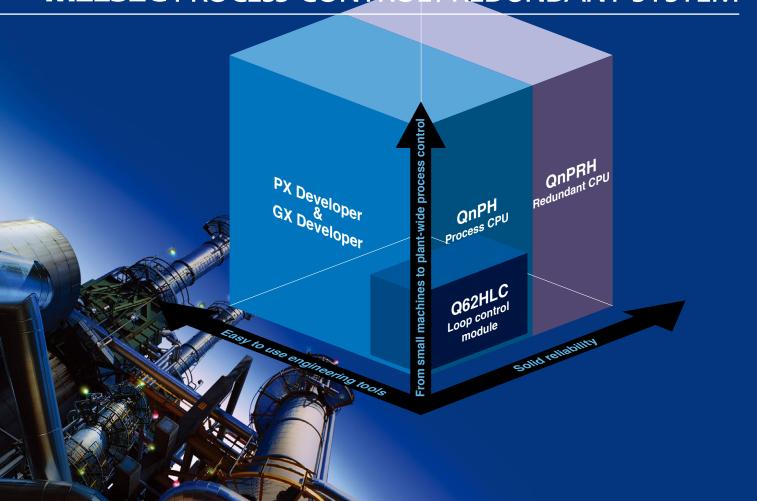
Implement sophisticated process control

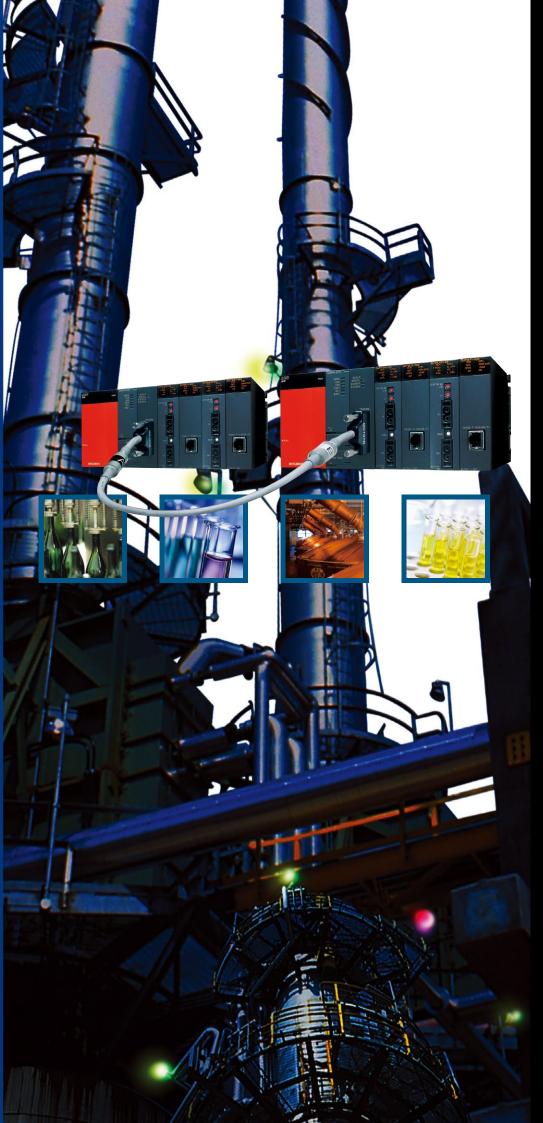
Designed to handle large numbers of proportional, integral, and derivative operations (PID loops), Mitsubishi process and redundant CPUs are well suited for demanding control applications.

Maximize system availability

Increase reliability and prevent important processes from being interrupted by using redundant CPUs and hardware. In the event of a failure, modules can be hot swapped.

MELSEC PROCESS CONTROL/REDUNDANT SYSTEM







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Needs

Design and create a process control system using programmable controllers.

- Similar functionality to a DCS with high speed operations
- Easy to create loop control programs
- Reduced system cost (low initial investment, maintenance, and modification)
- Same level of reliability compared to DCS

Solutions

MELSEC process control provides loop control processing, high speed analog processing, and easy to use engineering tools. Create fully redundant systems using two CPUs, two power supplies, etc.

Loop control

Process and redundant CPUs provide high-speed loop and sequence control with phenomenal reliability. Q series analog modules have many features including channel isolation, high accuracy, high resolution, and the ability to detect disconnections.

Simplified engineering

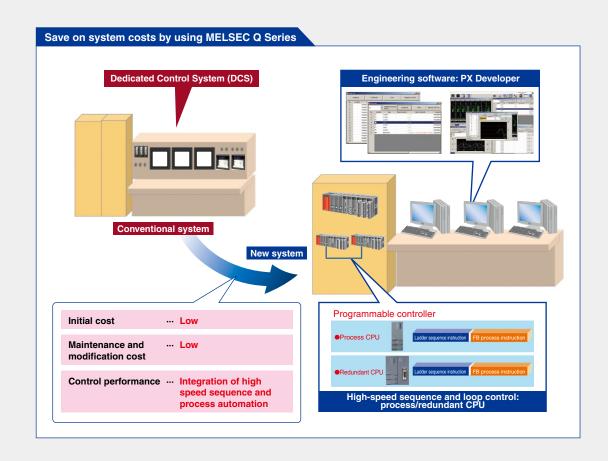
PX Developer includes as standard, all of the necessary FBs (function blocks) for loop control. Loop control programs can be created quickly and easily by drag & drop operation. (No need for ladder programming) Additionally, tuning and monitoring each loop tag is made easy thanks to a standard interface.

Maintenance

Temperature control, analog, I/O, and other modules may be hot swapped; that is, they can be replaced while the system is powered on and running.

■ Redundant system

The redundant system (including the CPU module, power supply module, base unit, and network module) can maximize the system uptime. Special programming is not required, and can be done just like a regular system.





Reduce space requirements and improve operator-friendliness

- Minimize space required for control panel installation
- User friendly operator interface
- Easily monitor and operate the system without a PC

Solutions

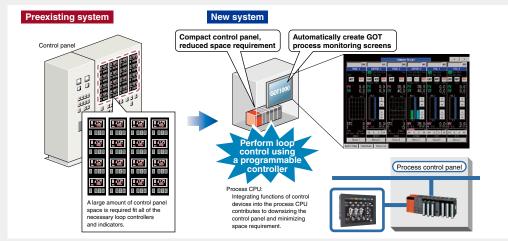
A MELSEC controller and GOT can take the place of many loop controllers and bulky switches, indicators, etc.

Reduced space requirements

The compact size and modularity of Q Series allows significant control panel space to be saved compared to alternative systems.

Enhanced monitoring and operation capabilities

Pre-made GOT screens for alarm list, event list, and others are available to improve monitoring and operational capabilities.



Needs

Integrate loop control and sequence control.

- There is a demand for an easy to design, modify, and maintain system that supports both loop and sequence control. (Current system design uses separate controllers)
 - Separate software required for each controller. Complicated programming for data communication between controllers



Program design, modification, and maintenance are time-consuming.

System scalability: expandable to other applications such as motion control and information control.

Solutions

A single process CPU can execute both loop and sequence control. Implementing a multiple CPU system is the perfect way to control other applications.

The process CPU and redundant CPU can execute multiple programs. Therefore, loop and sequence control can be performed simultaneously at high speed.

■ Integration of loop control and sequence control ■ Cover multiple control disciplines using a multiple CPU system

Any Q Series module can be used in a multiple CPU system, which allows great flexibility in system design, construction, and maintenance. Applications requiring highspeed motion control (motion CPU), information control (PC CPU), etc. can be combined.

*Redundant CPUs do not support multiple CPU configurations.

Execute sequence control and process control simultaneously



Superior performance compared to DCS

The sequence instructions of the MELSEC-Q Sequence control series can be used without any changes.

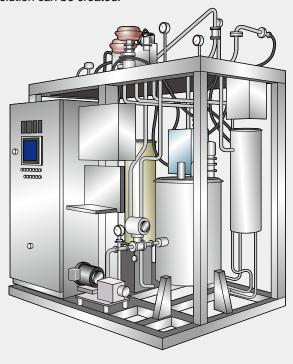
> There are over 50 types of process instructions available for a diverse range of applications such as cascade and feed-forward control.

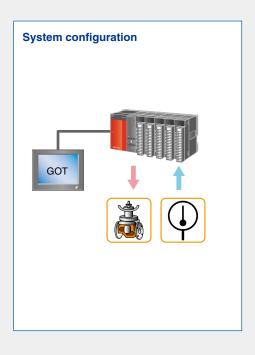
2 degree-of-freedom advanced PID	Set point generation FB	Sample Pl	Blend Pl	Auto tuning	
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Food processing



Applications previously requiring separate sequence and temperature control can now be controlled using a single process CPU. When a GOT is used in conjunction with the system, a space-saving, superior monitoring and control solution can be created.



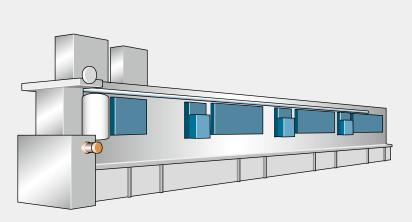


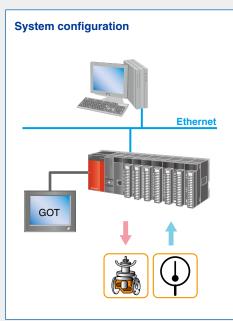
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Industrial furnace



Implement process control using a wide variety of high-speed sequence and loop control instructions.



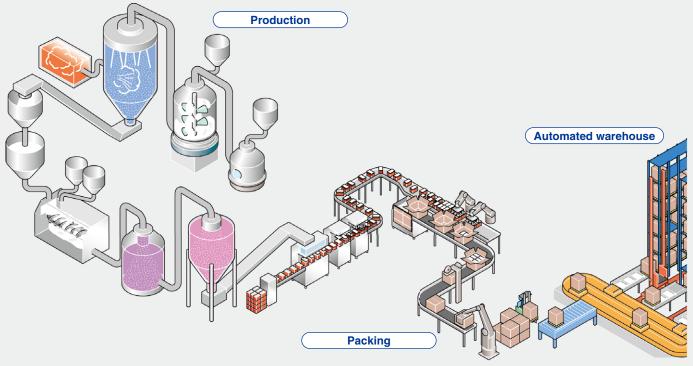


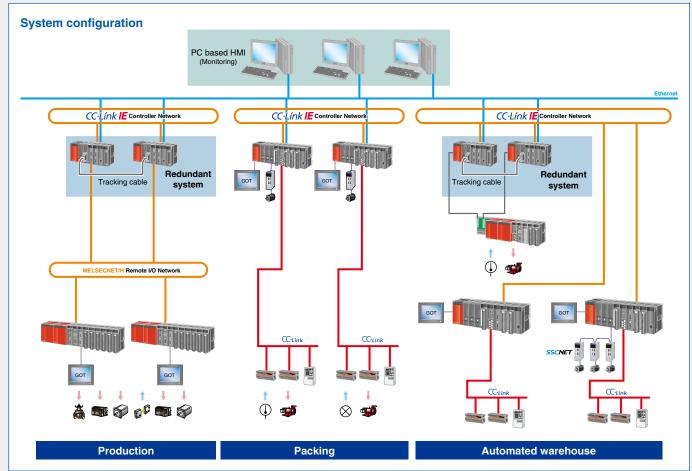


Tine chemical manufacturing



Mitsubishi Electric products help to provide integrated solutions for process automation and factory automation. Our process oriented products are well suited for manufacturing chemicals, such as medicines, paint, cosmetics, and detergent. Initial and running costs can be reduced compared to common alternatives.





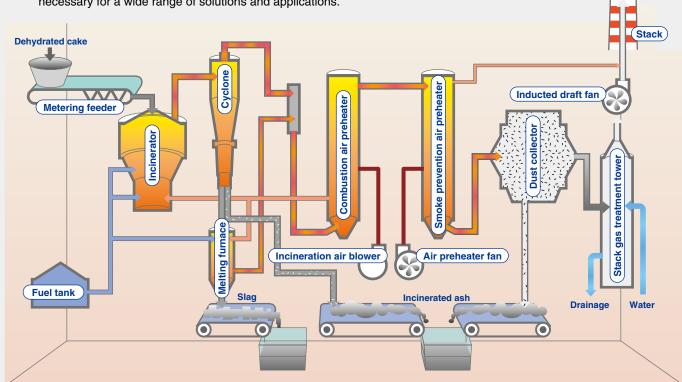
Water treatment Create sophisticated systems for safe and stable water treatment using highly reliable redundant CPUs. final sedimentation tank sedimentation tank **Park** Sludge treatment facility Discharge Chlorine contact tank Settling basin (Aeration tank) (Advanced treatment facility) **System configuration** PC based HMI **Ethernet** Switching hub . Redundant Redundant Redundant Redundant Tracking Tracking Tracking Tracking system system system system MELSECNET/H Remote I/O Network MELSECNET/H Remote I/O Network MELSECNET/H Remote I/O Network MELSECNET/H Remote I/O Network CC-Link IE Controller Network GOT GOT GOT GOT GOT GOT GOT Recycling sludge pump, Water tank, coarse filter, Blower, tank, chlorination final sedimentation tank, water recycling tower, fine filter, water pump pressure pump, adjustment sewage pump

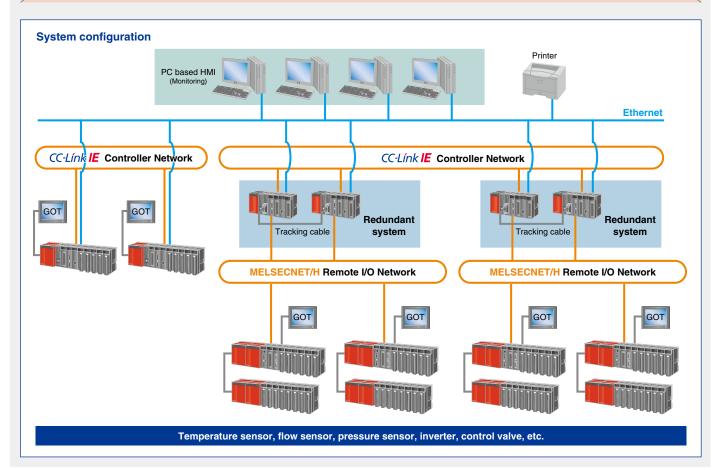


Waste incineration



Create the optimal control system to match the scale of operation. Mitsubishi Electric process automation products are highly flexible and ready to provide the core elements necessary for a wide range of solutions and applications.



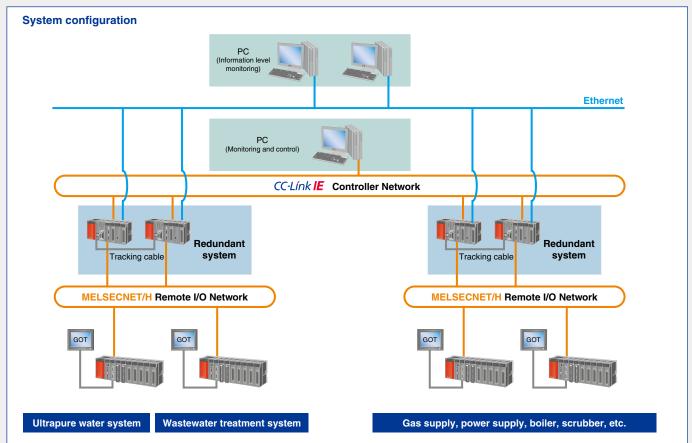


Semiconductor manufacturing



The dependability of purified water and gas supply systems for semiconductor applications can be increased by implementing a redundant system. Even if one programmable controller happens to fail, the other CPU is ready to immediately take over control and continue the operation without interruption.



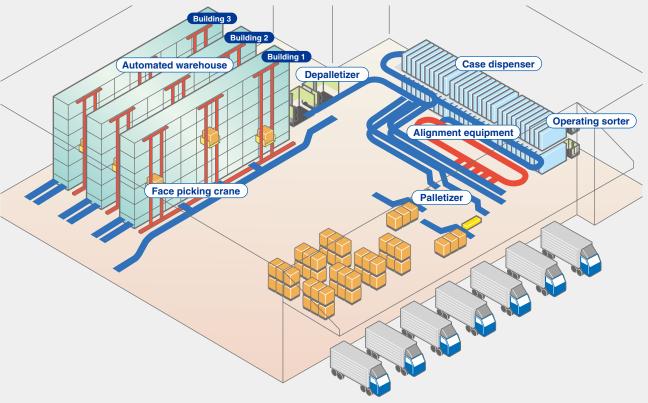


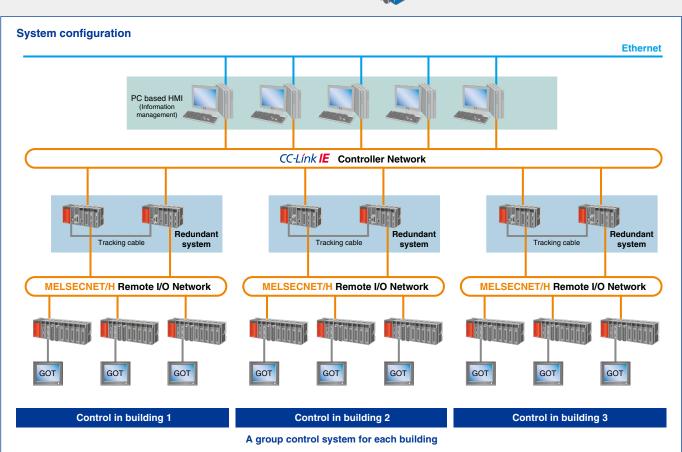


Material handling



Utilizing redundant systems for material handling applications ensures steady, consistent operation. The end result is a reduction in loading/unloading delays due to control system issues.





Reduce costs by combining FA (Factory Automation)

PC for monitoring and engineering



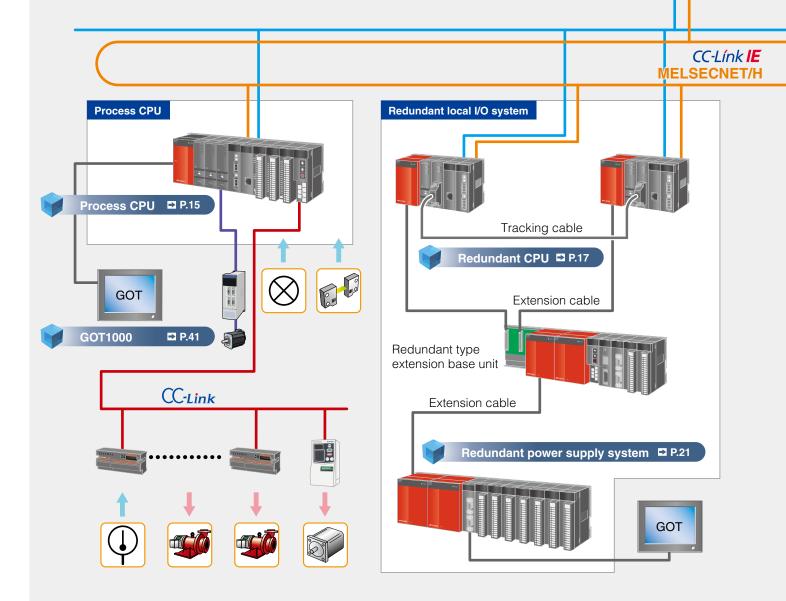
Design, debug, modify, and monitor FBD (Function Block Diagram) loop control programs.



(MELSEC programmable controller programming software)

The primary programming, debugging, maintenance, and troubleshooting engineering tool for process and redundant CPUs.











Temperature Sensor (i.e., limit switch)



Control valve Solenoid valve







and PA (Process Automation) in the same platform.



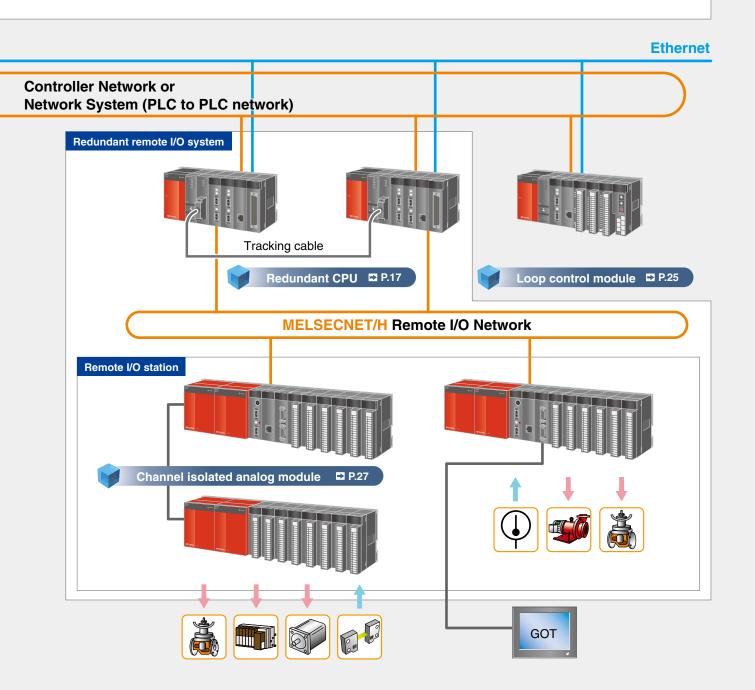
(ActiveX[®] library for programmable controller communication)

Allows user programs (on the PC) to interface with Mitsubishi programmable controllers via the network.



(HMI software)

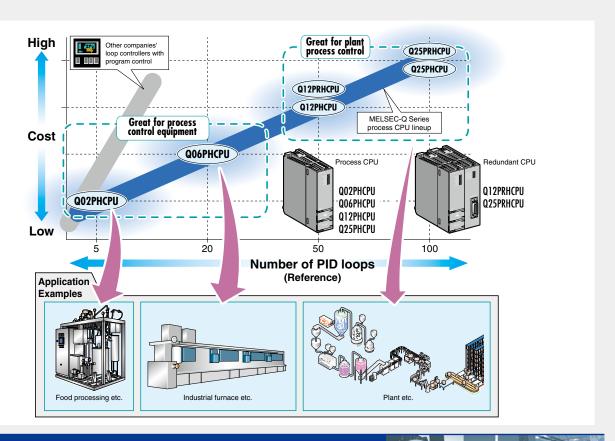
Enables a PC to function as a graphic operation terminal using the same screen design software available for the GOT.



CPU (process & redundant)

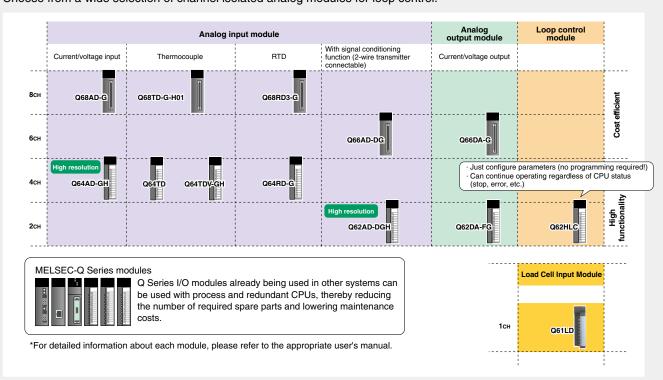


Choose the optimum CPU based on the number of PID loops required and the scale of the application.



Modules best suited for loop control





Process monitoring solutions

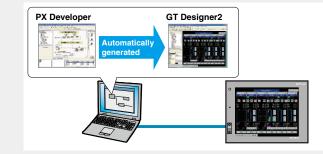


Choose a control and monitoring solution that is right for the situation.

Category	Application	Solution	Feature
HMI based	General	GOT screen generation function	Excellent environmental resistance Compatible with high resolution (15" XGA) Create process control and monitoring screens for the GOT1000 series automatically
	monitoring and control	Combination of PX Developer Monitor tool and SoftGOT SoftGOT interface	Use GT Designer2 or GT Designer3 to create GOT screens for the PC Graphically represent operations on the shop floor to aid the quick understanding of system status
PC based	Complex monitoring and control	Commercial SCADA SCADA system interface	Better flexibility and range of functionality Links to enterprise system

GOT screen generation function

GOT screens for monitoring, tuning, etc. can be automatically generated from programs created using PX Developer. This feature eliminates the time consuming tasks of assigning devices and programming GOT screens to substantially reduce development time. See page 37 for details.



SoftGOT interface

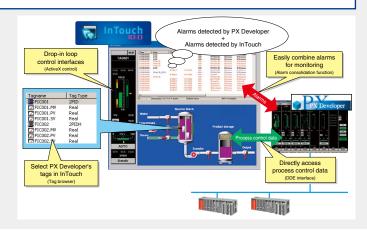
PX Developer monitoring functions can be 'called' or opened directly from GT SoftGOT1000 screens. Consequently, the development time for creating GOT screens can be reduced.



SCADA system interface

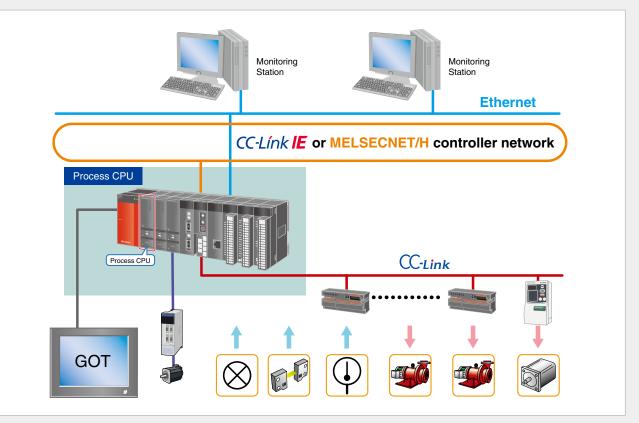
SCADA systems such as Wonderware InTouch by Invensys Systems, Inc. can be used to create advanced graphical displays of the system status. The PX Developer monitoring tool is designed to interface with SCADA software and its monitoring functions may be called and opened directly by the SCADA software.

The company and product names above are trademarked by their respective companies.



Process CPU





Features

Integrated loop control and sequence control

- A single CPU can execute multiple programs simultaneously, thus loop control and sequence control programs can be processed at high-speed by the same CPU unit.
- Process CPUs may be used in multi-CPU systems to cover different areas of control such as high-speed motion control (motion CPU), or information control (PC CPU).

Extensive loop control

 The MELSEC Process CPU features 52 instructions dedicated for process control including a two-degree-of-freedom PID, sample PI, auto-tuning, and other instructions to support loop control.

High-speed loop control

With high-speed loop processing of approximately 400 µs (2-degree-of-freedom PID), control cycles as short as 10 ms can be achieved. Therefore, more loops can be executed simultaneously and applications requiring high-speed control cycles can be satisfied.

Improved reliability and maintenance features

- When an analog or I/O module fails, it can be replaced without stopping or turning off the CPU. (Note 1) (GX Developer is required.)
- Output behavior (hold previous state, etc.) in the event the CPU stops due to error can be set via parameter.

Simple engineering

· Create process control programs using PX Developer, an easy-to-use FBD language engineering tool.

Compatibility and expandability

 The process CPU is compatible with all Q Series modules and is therefore well suited to take on a wide variety of applications.

Ample CPU lineup

 From small machines to plant-wide process control, a CPU is available to match the application.

Improved total system throughput

 In combination with the high-speed, high-bandwidth CC-Link IE controller network, operations involving remote I/O stations and other networked controllers benefit drastically by improved response time and overall productivity.

Note 1) Online module change function (Function version restrictions)

Note 1) Online module change function (Function Version restrictions)				
Product name	Restrictions			
Input module				
Output module	No restrictions			
I/O composite module				
Analog input module				
Analog output module				
Temperature input module	Version C			
Temperature control module				
Channel isolated pulse input module				

Note 2) To be compatible with the CC-Link IE network module, the first five digits of the CPU module's serial number must be 10042 or later



Specifications

		Item		Q02PHCPU	Q06PHCPU	Q12PHCPU	Q25PHCPU
Control method			Sequence program control method				
I/O control mode			Refresh				
Sequence control language			Ladder, list, ST, SFC				
Program language	Pro	cess control langu	uage		Process contr	rol FBD (Note 1)	
	0		LD instruction		34 ns 102 ns		
		quence ruction (Note 2)	MOV instruction				
Processing speed	11130	idollori ()	Floating point addition		782	2 ns	
	Pro	cess instruction	2 degree of freedom PID		400	μs	
	(loc	p process time)	Basic PID		350	μs	
Program capacity	Nur	mber of steps		28 k steps	60 k steps	124 k steps	252 k steps
Frogram capacity	Nur	mber of programs		28	60	124	252 (Note 3)
Duilt in momony	Sta	ndard RAM		128 k	bytes	256 k	bytes
Built-in memory	Sta	ndard ROM		112 k bytes	240 k bytes	496 k bytes	1008 k bytes
I can control	Pro	cess control instru	uctions		5	2	
Loop control specifications	Cor	ntrol cycle		10 m	s or more/control loop	(setting available pe	r loop)
Specifications	Mai	in functions		2 degree of freedom F	PID control, cascade co	ntrol, auto-tuning function	on, feed forward contro
Number of I/O device	ce poi	nts (Note 4)			8192	points	
Number of I/O point					4096	points	
Internal relay [M]					8192	points	
Latch relay [L]					8192	points	
Link relay [B]					8192	points	
Timer [T]	1				2048	points	
Retentive timer [ST]	ī	0)		0 points			
Counter [C]	(Note 6)		1024 points				
Data register [D]			12288 points				
Link register [W]				8192 points			
Annunciator [F]	1				2048	points	
Edge relay [V]	1				2048	points	
				Max. 65536 points can be used by block Max. 131072 points can be used by block			
		Standard RAM		switching in units of 327	768 points (R0 to 32767)	switching in units of 327	'68 points (R0 to 32767
	[D]	SRAM card (1 M	MB)	Max. 517120 points of	can be used by block sw	vitching in units of 32768	points (R0 to 32767)
	[R]	SRAM card (2 M	MB)	Max. 1041408 points	can be used by block sv	vitching in units of 3276	8 points (R0 to 32767)
		Flash card (2 Mi	B)	Max. 1041408 points	can be used by block sv	vitching in units of 3276	8 points (R0 to 32767)
File vesietev		Flash card (4 Mi	B)	Max. 1042432 points can be used by block switching in units of 32768 points (R0 to 32767)			
File register		Ctondord DAM		65536 points	(R0 to 65535),	131072 points	(R0 to 131071),
		Standard RAM		block switchin	ng not required	block switchin	g not required
	[ZR]	SRAM card (1 M	MB)	517120 points (R0 to 517119), block switching not required			
	[ZN]	SRAM card (2 M	MB)	1041408 points (R0 to 1041407), block switching not required			
		Flash card (2 Mi	B)	1041408	points (R0 to 104140	block switching no	t required
		Flash card (4 Mi	B)	1042432	points (R0 to 104243	block switching no	t required
Link special relay [S	BB]				2048	points	
Link special register	r [SW]				2048	points	
Step relay [S]					8192	•	
Index register [Z]	Index register [Z]		16 points				
Pointer [P]			4096				
Interrupt pointer [I]			256 բ				
Special relay [SM]			2048				
Special register [SD]			2048				
Function input [FX]		16 points					
Function output [FY	•				16 p		
Function register [F					5 pc		
Number of mountab					Max		
Number of mountab					Max		
Number of extension base stages					Max	x. 7	

Software packages

PX Developer is used together with GX Developer. The following software versions are required for programming the process CPU.

Product name	w/ CC-Link IE	w/o CC-Link	IE connection
Product name	connection	Q02/06PHCPU	Q12/25PHCPU
GX Developer	Version 8.68W or later		Version 7.20W or later
PX Developer	Version 1.18U or later		Version 1.00A or later

Note 1) PX Developer is required to write programs using FBD.

Note 2) The processing time is the same even when using indexed devices.

Note 3) Up to 124 programs can be executed.

Note 4) Indicates the total number of I/O points on the main base unit and extension base units directly controlled by the CPU module and the number of I/O points controlled as remote I/O via the remote I/O network. Note 5) Indicates the number of I/O points on the main base unit and extension base units directly controlled by the CPU module.

Note 6) Indicates the default number of points. These can be changed via parameters.

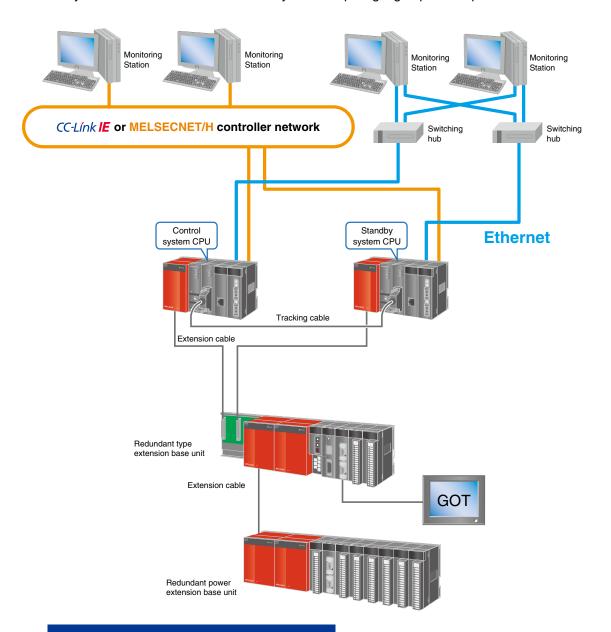
Redundant CPU



Redundant CPU, network, and power supply systems are provided to support various system configurations specific to application requirements.

Redundant local I/O system

The CPU directly accesses I/O modules. Ideal for systems requiring high-speed response.



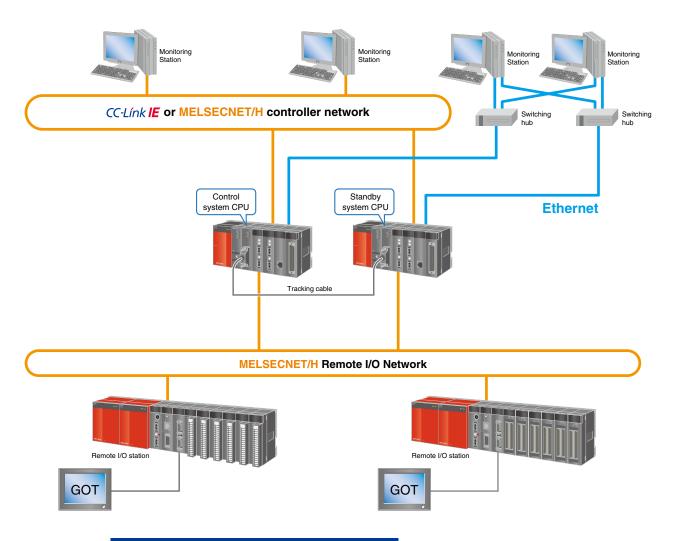
System switching time (Reference)

Approximately 50 ms (Local I/O response time)

- \cdot Standby CPU tracking data acquisition time
- · CPU switching time: Min. 32 ms (without signal flow tracking)

Redundant remote I/O system

Ideal for distributed systems with multiple remote I/O stations.



System switching time (Reference)

Approximately 800 ms (Remote I/O response time)

- \cdot Standby CPU tracking data acquisition time
- \cdot Output holding time of remote I/O station during control system switching: 700 to 800 ms
- · CPU switching time: Min. 21 ms (signal flow without tracking)



Redundant CPU





Features

Basic system/network with redundancy

- The basic system, including the CPU module, power supply module, base unit, and network module, can be configured with redundancy.
- Networks can be configured with redundancy. When the network module fails or cable disconnection is detected, the standby system continues control and communications.

Improved reliability and maintainability

- With the redundancy of the basic system, the standby system takes over the control to continue the system operation when the control system fails. (Hot standby)
- By replacing the failed module or entire system, the redundant system can be recovered quickly.
- When an I/O, analog I/O, temperature input, temperature control, or channel isolated pulse input module on the redundant extension base unit or remote I/O station fails, it can be replaced without stopping or turning off the CPU. (Note 1, 2) (Operation on GX Developer is required.)
- When the CPU module is replaced while the system is operating, the parameters and programs can be copied to the new CPU by transfer instruction from GX Developer.

Loop control and sequence control in one CPU

 A single CPU can execute multiple programs simultaneously, thus loop control and sequence control programs can be processed at high-speed by the same CPU unit.

Simple engineering

- GX Developer offers simple engineering environment for redundant system settings with the original operability.
- PX Developer facilitates creating loop control programs using FBD language.
- Writing parameters and programs is simple using GX Developer regardless of the system status (control/ standby).

Employs existing Q Series modules

 The Q Series modules, such as I/O, intelligent function, and network modules, can be used without any changes. (Note 3)



Improved total system throughput

 In combination with the high-speed, high-bandwidth CC-Link IE controller network, operations involving remote I/O stations and other networked controllers benefit drastically by improved response time and overall productivity.

Note 1) The following modules on the extension base unit or remote I/O station can be replaced while online.

Product name	Restrictions	Product name	Restrictions
Input module		Analog output module	
Output module	No restrictions	Temperature input module	Version C or later
I/O composite module		Temperature control module	version C or later
Analog input module	Version C or later	Channel isolated pulse input module	

Note 2) When the redundant type extension base unit is used, I/O modules on the main base unit cannot be replaced while online. Note 3) Use the following serial No. or version for the redundant system.

Product name	Model	Serial No. or Version
Redundant CPU	Q12PRHCPU	First five digits of the serial number are 09012 or later (when the redundant type extension base unit is used);
neutritarit Gr 0	Q25PRHCPU	First five digits of the serial number are 10042 or later (when the CC-Link IE Controller Network module is used)
CC-Link IE Controller Network	QJ71GP21-SX	No restrictions
module	QJ71GP21S-SX	
	QJ71LP21-25	
MELSECNET/H master module	QJ71LP21S-25	
WEEGEGIVE 1/11 master module	QJ71LP21G	
	QJ71BR11	
MELSECNET/H remote I/O module	QJ72LP25-25	
	QJ72LP25G	
	QJ72BR15	
	QJ71E71-B2	Version D or later
Ethernet interface module	QJ71E71-B5	
	QJ71E71-100	
	Q81BD-J71LP21-25	
	Q80BD-J71LP21-25	
MELSECNET/H interface board	Q80BD-J71LP21S-25	
	Q80BD-J71LP21G	
	Q80BD-J71BR11	
CC-Link interface module	QJ61BT11N	First five digits of the serial number are 06052 or later (when it is mounted on the main base unit)
MES interface module	QJ71MES96	First five digits of the serial number are 09012 or later
Web server module	QJ71WS96	i iist live digits of the serial Hullibel are 09012 of latel

The following functions are not available for the module mounted on the extension base unit.

· Interrupt pointer

[·] Intelligent function module dedicated instructions



Specifications

	Item		Q12PRHCPU	Q25PRHCPU	
Control method			Sequence progra	m control method	
I/O control mode			Refr		
Sequence control language		Ladder, list, ST, SFC			
Program language	Process control langu		Process contr		
		LD instruction	34		
	Sequence	MOV instruction	102		
	instruction (Note 2)	Floating point addition	782		
Processing speed	Process instruction	2 degree of freedom PID	400		
1 Toocssing specu	(loop process time)	Basic PID		•	
	(loop process time)	Tracking execution time	350	•	
	Redundant function	(extended scan time)		e memory: 10 ms	
	Number of stone	(exterided scarr time)	100 k word device		
Program capacity	Number of steps		124 k steps	252 k steps	
	Number of programs		124	252 (Note 3)	
Built-in memory	Standard RAM		256 k	•	
	Standard ROM		496 k bytes	1008 k bytes	
Loop control	Process control instru	uctions	5		
specifications	Control cycle		10 ms or more/control loop		
•	Main functions		2 degree of freedom PID control, cascade con		
Number of I/O device	ce points (Note 4)		8192		
Number of I/O points	S (Note 5)		4096		
Internal relay [M]			8192	points	
Latch relay [L]			8192	points	
Link relay [B]			8192	points	
Timer [T]			2048 points		
Retentive timer [ST]	(Note 6)		0 points		
Counter [C]			1024 points		
Data register [D]			12288 points		
Link register [W]			8192 points		
Annunciator [F]			2048 points		
Edge relay [V]			2048 points		
,,,,	Standard RAM		Max. 131072 points can be used by block sw	itching in units of 32768 points (R0 to 32767)	
	SRAM card (1 MB) [R] SRAM card (2 MB)		Max. 517120 points can be used by block switching in units of 32768 points (R0 to 32767)		
			Max. 1041408 points can be used by block switching in units of 32768 points (R0 to 32767)		
	Flash card (2 MI	B)	Max. 1041408 points can be used by block sw	vitching in units of 32768 points (R0 to 32767)	
File we winter	Flash card (4 MI	B)	Max. 1042432 points can be used by block sw	vitching in units of 32768 points (R0 to 32767)	
File register	Standard RAM		131072 points (R0 to 131071)	, block switching not required	
	SRAM card (1 M	1B)	517120 points (R0 to 517119)	, block switching not required	
	[ZR] SRAM card (2 M	MB)	1041408 points (R0 to 104140)	7), block switching not required	
	Flash card (2 MI	B)	1041408 points (R0 to 104140)	7), block switching not required	
	Flash card (4 MI	B)	1042432 points (R0 to 104243)	1), block switching not required	
Link special relay [S	BB]	,	2048	points	
Link special register			2048	points	
Step relay [S]			8192		
Index register [Z]			16 pc		
Pointer [P]			4096		
Interrupt pointer [I]			256 p		
Special relay [SM]			2048		
Special register [SD]		2048			
	Function input [FX]		16 points		
Function output [FY]		16 pc			
Function register [FI			5 pc		
Number of device tra			Max. 1024		
Number of mountab			1 (multiple CPU sy		
Number of mountab				c. 63	
Number of extension			Max		
Number of remote I/			8192 points (max. 2		
	o pointo		OTOL POINTS (IIIAX. 2	-o .o ponito/otation/	

Note 1) PX Developer is required to write programs using FBD.

Note 2) The processing time is the same even when using indexed devices.

Note 3) Up to 124 programs can be executed.

Note 4) Indicates the total number of I/O points on the main base unit and extension base units directly controlled by the CPU module and the number of I/O points controlled as remote I/O via the remote I/O network.

Note 5) Indicates the number of I/O points on the main base unit and extension base units directly controlled by the CPU module.

Note 6) Indicates the default number of points. These can be changed via parameters.

Software packages

PX Developer is used together with GX Developer. The following version or later is required for programming the redundant CPU.

		w/o CC-Link IE connection		
Product name	w/ CC-Link IE connection	Redundant type extension	Redundant type extension	
		base unit used	base unit not used	
GX Developer	Version 8.68W or later	Version 8.45X or later	Version 8.18U or later	
PX Developer	Version 1.18U or later	Version 1.14Q or later	Version 1.06G or later	



Redundant power supply system

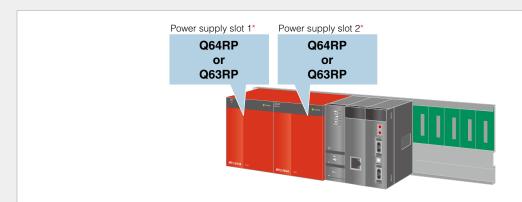


The redundant power supply system can be configured to back up the system in the event of a power failure.



Redundant power supplies supporting all CPUs

- 1. Even if one power supply module fails, the other one supplies the power to the system.
- 2. A failed power supply module can be confirmed by a "power failure detection function" or "LED indicators", allowing for quick replacement. This ensures system backup.
- 3. The power supply module can be replaced while online.
- 4. Q64RP (AC input) and Q63RP (DC input) can be used together. Creating two power supply systems (AC and DC) further enhances system reliability.



* Either Q64RP or Q63RP can be mounted on the power supply slot 1 and 2. Also, in the event of a power failure, the power supply module can be replaced while online.



Specifications

Item		Q64RP	Q63RP	
Applicable base unit		Q38RB, Q65WRB		
Input power supply		100 to 120 V AC/200 to 240 V AC (+10%, -15%) (85 to 132 V AC/170 to 264 V AC)	24 V DC (+30%, -35%) (15.6 to 31.2 V DC)	
Input frequency		50/60 Hz ±5%	N/A	
Input voltage distor	rtion rate	Within 5%	N/A	
Maximum input ap	parent power	160 VA	N/A	
Maximum input po	wer	N/A	65 W	
Inrush current		20 A, 8 ms or less	150 A, 1 ms or less	
Rated output current		8.5 A		
Overcurrent protect	etion	9.35 A or more		
Overvoltage protect	ction	5.5 to 6.5 V		
Efficiency		65% or more		
Allowable moment	ary power failure period	20 ms or less	10 ms or less (at 24 V DC input)	
	Application	ERR contact		
	Rated switching voltage/current	24 V DC/0.5 A		
	Minimum switching load	5 V DC	, 1 mA	
Contact output	Response time	OFF to ON: 10 ms or less,	ON to OFF: 12 ms or less	
Contact output	Life	Mechanical: 20,000,000 times or more		
	LIIE	Electrical: 100,000 times or more at rated switching voltage and current		
	Surge suppressor	No	0	
	Fuse	N	0	



Fiber optic loop network module with external power supply function



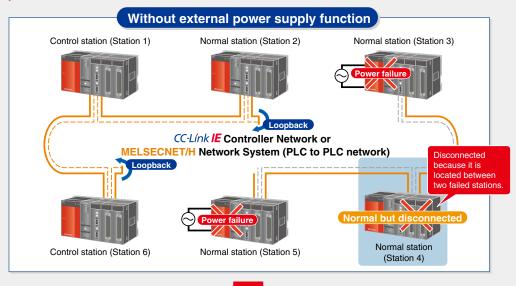
The external power supply function enables the system to continue data link when the power supply module fails.

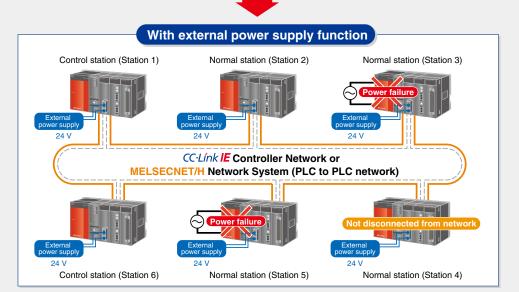


External power supply prevents the system from being affected by a power failure

Even if a power failure occurs at more than two stations in a loop system, a station in between can continue data link. This function also prevents loopback in the system. The link scan time can be stabilized, ensuring steady system operation.

When a power failure occurred in two stations:





Specifications

ltem		CC-Línk IE Controller Network module QJ71GP21S-SX	MELSECNET/H network module QJ71LP21S-25	
	Voltage	20.4 to 3	1.2 V DC	
	Current	0.28A	0.20A	
	Terminal screw size	МЗ		
External	Applicable solderless terminal	R1.25-3		
power supply	Applicable wire size	0.3 to 1.25 mm ²		
	Tightening torque	0.42 to 0.58 N·m		
	Allowable momentary power failure time	1 ms (Level PS1)		
Noise immunity By noise simulator of 500Vp-p noise voltage, 1µs pulse width, and 25 to 60Hz noise			us pulse width, and 25 to 60Hz noise frequency	



Multiplexed remote I/O network system



Redundant system with superior cost effectiveness by using highly reliable, high-speed network.



Features

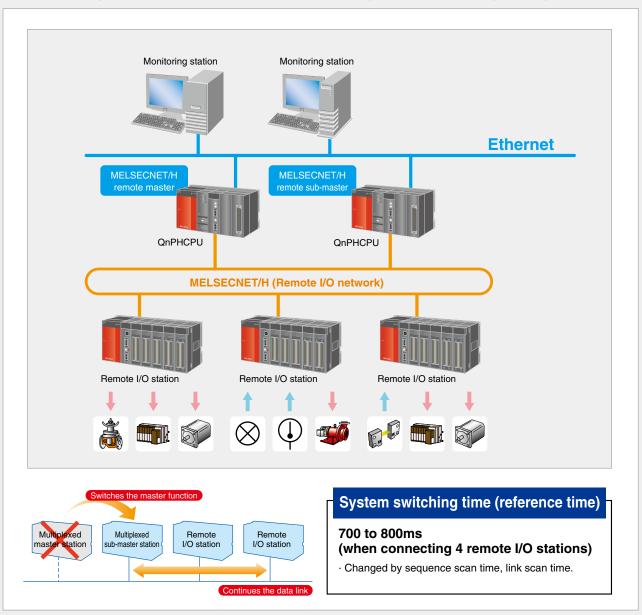
Facilitating the multiplexed remote master station and multiplexed remote sub-master station on one remote I/O network system enables the multiplexed remote sub-master station to control the remote I/O network system instead when the programmable controller CPU in the multiplexed remote master station becomes faulty.

The multiplexed remote master station can return to normal and to system operation as a multiplexed remote sub-master station, even during the remote I/O network system control by the multiplexed remote sub-master station, thus preparing itself for a multiplexed remote sub-master station.

System configuration

- ■Usable CPU is Process CPU (QnPHCPU).
- ■The redundant system configured with QnPHCPU + MELSECNET/H (remote I/O network). (Note 1)
- ■The multiplexed remote function enables the multiplexed remote sub-master station to continue the I/O working when the multiplexed remote master station becomes faulty due to a malfunction in power supply, etc.

(Note 1) When tracking is needed, the communication module (Ethernet, etc.) to communicate the tracking data and the creation of the user program for tracking is required.





🗘 CC-Link Master station duplex function 🥌



Cost-saving redundant system by using open field network.



Features

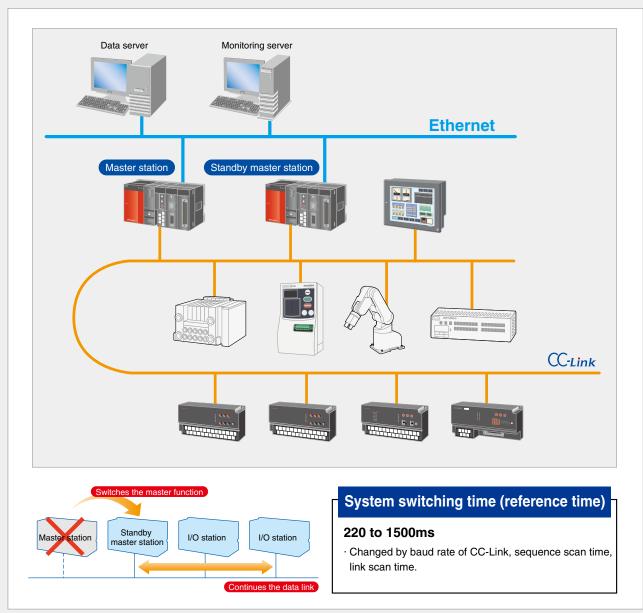
The CC-Link Master station duplex function enables the data link to continue working by switching the control to the standby master station (meaning a backup station for the master station) automatically if system down occurs in the master station due to a malfunction in the programmable controller CPU or power supply.

The master station can return to normal and to system operation as the standby master station, even during data-link control by the standby master station, thus preparing itself for the standby master station system down.

System configuration

- ■The redundant system can be configured in CC-Link network regardless of the CPU types of the master station, standby master station. (Note 2)
- ■The CC-Link Master station duplex function enables the standby master station to continue the data link working when the master station becomes faulty. The master station can return to normal and to system operation as the standby master station, even during data-link control by the standby master station.

Note 2) When tracking is needed, the communication module (Ethernet, etc.) to communicate the tracking data and the creation of the user program for tracking is required.



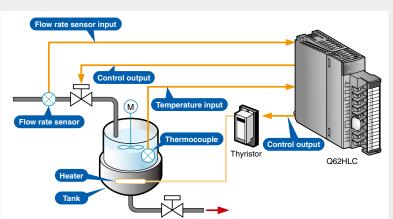


Loop control module



Ideal for fast response control such as

- Rapid temperature increase control in flip chip bond IC manufacturing
- Drying oven cooling temperature control on freeze drying machines
- Staggering 25 ms sampling and control update time, industry's fastest.
- Supports sensor types, such as thermocouple, microvoltage, and current input ranges.
- Continuous PID control by 4 to 20 mA current output results in highly stable and accurate control.



Features

High-speed PID control

The Q62HLC loop control module performs a continuous PID control and supports thermocouple inputs, microvoltage inputs, voltage inputs, current inputs, and current outputs. These features make the Q62HLC ideal for fast response control.

2 Connectable to thermocouples complying with major international standards

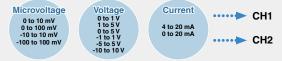
Thermocouples complying with the JIS, IEC, NBS, and ASTM standards are supported.

Items complying with any of these can be used



Supports a variety of input ranges

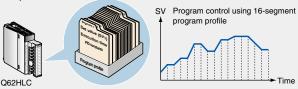
The use of an input sensor (microvoltage, voltage, and current inputs) enables analog value measurements in the ranges shown below.



1

Program control function

Control program profiles can be specified where set values (SV) and PID constants (Proportional band, Integral time, Derivative time) are automatically changed at specified times.

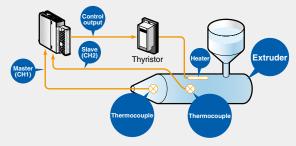




Cascade control function

Cascade control can be performed with channel 1 as the master and channel 2 as the slave.

Resin nozzle temperature control





Specifications

Item			Specifications				
Nur	Number of analog I/O points		2 channels/module				
Analog input spec			fications Analog output specifications				
Number of input points			2 points (2 channels)	Number of output points		2 points (2 channels)	
Ana	alog input		See (2)	Digital inpu	ut	16-bit signed binary	
Dig	ital output		16-bit signed binary	Analog out	tput	Current	
Usa	able thermocouples		K, J, T, S, R, N, E, B, PL II, W5Re/W26Re		-	-	
Inp	Input characteristics		See (1)	Output characteristics		Digital input value: 0 to 1000 (0 to 4000 when using simplified analog output) Output range: 4 to 20 mA	
Max	ximum resolution		See (1)	Maximum resolution		4 μΑ	
xe2)	Indication accuracy	Ambient temperature: $23^{\circ}C \pm 2^{\circ}C$	See (2) (a)	Output	Ambient temperature: 23°C ± 2°C	Full scale x (±0.2%)	
Š	indication accuracy	Ambient temperature: 0°C to 55°C	See (2) (b)	accuracy	Ambient temperature: 0°C to 55°C	Full scale x (±0.4%)	
ccuracy	Cold junction temperature	Ambient temperature: $23^{\circ}C \pm 2^{\circ}C$	±0.5°C	-			
Acc	compensation accuracy	Ambient temperature: 0°C to 55°C	±1.0°C			-	
Cor	Conversion speed		25 ms/2channels (constant regardless of the number of channels used)	Conversion speed		25 ms/2channels (constant regardless of the number of channels used)	
Sar	Sampling period		25 ms/2channels (constant regardless of the number of channels used)	Control update time		25 ms/2channels (constant regardless of the number of channels used)	
Abs	Absolute maximum input		Microvoltage: \pm 12 V, voltage: \pm 15 V, current: \pm 30 mA	Allowable	load resistance	600 Ω or less	
Inp	ut impedance		Thermocouple, microvoltage, voltage: 1 M Ω , current: 250 Ω	Output imp	pedance	5 ΜΩ	

Note 2) Accuracy is calculated as follows: [Accuracy] = [Indication accuracy] + [Cold junction temperature compensation accuracy]

(1) Usable input sensor types, measurement ranges, and data resolution

Input		Input range	Digital value	Resolution
	К	-200 to 1372°C	-2000 to 13720	
	J	-200 to 1200°C	-2000 to 12000	
	Т	-200 to 400°C	-2000 to 4000	
	S	-50 to 1768°C	-500 to 17680	
Thermocouple	R	-50 to 1768°C	-500 to 17680	0.1°C
Thermocouple	N	0 to 1300°C	0 to 13000	
	Е	-200 to 1000°C	-2000 to 10000	
	В	0 to 1800°C	0 to 18000	
	PL II	0 to 1390°C	0 to 13900	
	W5Re/W26Re	0 to 2300°C	0 to 23000	
		0 to 10 mV	0.400000	0.5 μV
Microvoltage		0 to 100 mV	0 to 20000	5 μV
Microvoltage		-10 to 10 mV	-10000 to 10000	1 μV
		-100 to 100 mV	-10000 to 10000	10 μV
		0 to 1 V		0.05 mV
		1 to 5 V	0 to 20000	0.2 mV
		0 to 5 V	0 10 20000	0.25 mV
Voltage		0 to 10 V		0.5 mV
-		-1 to 1 V		0.1 mV
		-5 to 5 V	-10000 to 10000	0.5 mV
		-10 to 10 V		1 mV
Current		4 to 20 mA	0 to 20000	0.8 μΑ
Current		0 to 20 mA	0 to 20000	1 μΑ

(2) Indication accuracy

(a) At ambient temperature of $23 \pm 2^{\circ}$ C

Item			Error
		Less than -100°C	± 1.0°C
	K, J, T, E, PL II	-100 to less than 500°C	± 0.5°C
		500°C or more	\pm [Indication value x (0.1%) + 1 digit]
Thermocouple	S, R, N,	-50 to less than 1000°C	± 1.0°C
Thermocouple	W5Re/W26Re	1000°C or more	± [Indication value x (0.1%) + 1 digit]
		Less than 400°C	± 70.0°C
	В	400 to less than 1000°C	± 1.0°C
		1000°C or more	± [Indication value x (0.1%) + 1 digit]
Microvoltage		·	
Voltage		F	Full scale x (±0.1%)
Current			

(b) At ambient temperature of 0 to 55°C

(4)				
	Item		Error	
		Less than -100°C	± 2.0°C	
	K, J, T, E, PL II	-100 to less than 500°C	± 1.0°C	
		500°C or more	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Thermocouple	S, R, N,	-50 to less than 1000°C	± 2.0°C	
Thermocouple	W5Re/W26Re	1000°C or more	± [Indication value x (0.2%) + 1 digit]	
		Less than 400°C	± 140.0°C	
	В	400 to less than 1000°C	± 2.0°C	
		1000°C or more	± [Indication value x (0.2%) + 1 digit]	
Microvoltage				
Voltage		Fu	ull scale x (±0.2%)	
Current				



Channel isolated analog modules



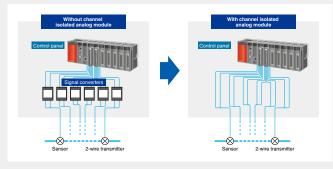
A wide selection of channel isolated analog modules are provided to meet requirements for process control and high-accuracy control.



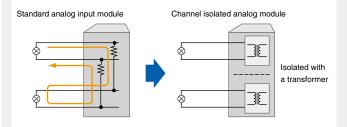
Features

High dielectric withstand voltage

External signal converters are not required.

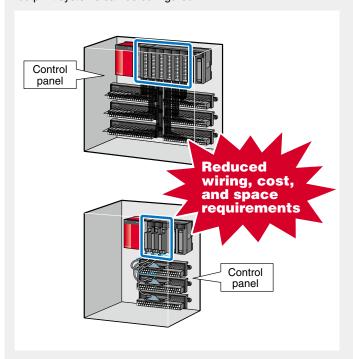


Electric disturbances such as current and noise can be isolated.



Cost and space requirement reduction (multi-channel type)

With multi-channel modules, more cost effective and small footprint systems can be configured.

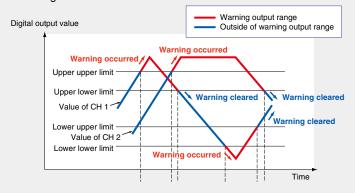


Disconnection detection function

When the analog output range is 4 to 20 mA or the user range setting of current, disconnection is detected by monitoring output values.

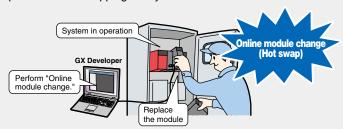
Warning and error detection functions

Analog modules monitor analog input signals and notify warnings and errors.



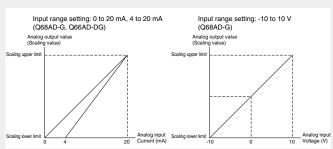
Online module change (hot swap)

Even if the analog module fails during operation, it can be replaced without stopping the system.



Scaling function (Q68AD-G, Q66AD-DG, Q66DA-G, Q68TD-G-H02)

A value input from an external device can be converted to an arbitrary value. This function eliminates the need for a ladder program that converts A/D conversion data to an actual physical value.





Specifications

Channel isolated high resolution analog input module

	Item	Q64AD-GH
No. of analog	input points	4 points (4 channels)
Analog input	Voltage	0 to 5 V DC, 1 to 5 V DC, 0 to 10 V DC, -10 to 10 V DC, user range
Analog Input	Current	0 to 20 mA DC, 4 to 20 mA DC, user range
Absolute max	. input	±15 V, ±30 mA
Digital	32-bit	0 to 64000 (0 to 5 V DC, 1 to 5 V DC, 0 to 10 V DC; 0 to 20 mA DC, 4 to 20 mA DC -64000 to 64000 (-10 to 10 V DC)
output	16-bit	0 to 32000 (0 to 5 V DC, 1 to 5 V DC, 0 to 10 V DC; 0 to 20 mA DC, 4 to 20 mA DC -32000 to 32000 (-10 to 10 V DC)
Accuracy (accuracy to max.	Reference accuracy	±0.05% Digital output value (32-bit): ±32 digits Digital output value (16-bit): ±16 digits
value)	Temperature coefficient	±71.4 ppm/°C (0.00714%/°C)
Conversion s	peed	10 ms/4 channels
Isolation meth	nod	Between I/O terminal and programmable controller power supply: Photocoupler Between analog input channels: Transformer
No. of occupi	ed I/O points	16 points (I/O assignment: Intelligent 16 points)
External conn	nections	18-point terminal block

Channel isolated high resolution analog input module (with signal conditioning function)

Stem Q62AD-DGH	
No. of analog input points 2 points (2 channels)	
Input points Analog input Ana	
Supply voltage 26±2 V DC	
Supply voltage 26±2 V DC Max. supply current 24 mA DC Chart circuit protection Ven (limit pursuant 05 to 25 mA)	
Short-circuit protection Yes (limit current: 25 to 35 mA)	
Check terminals Yes	
Digital 32-bit 0 to 64000	
output 16-bit 0 to 32000	
Accuracy (accuracy to max. digital output value (32-bit): ±32 digits Digital output value (16-bit): ±16 digits	
Temperature coefficient ±71.4 ppm/°C (0.00714%/°C)	
Conversion speed 10 ms/2 channels	
Between I/O terminal and programmable cont power supply: Photocoupler Isolation method Between analog input channels: Transform Between external power supply and analog input channel: Transformer	
No. of occupied I/O points 16 points (I/O assignment: Intelligent 16 points	nts)
External connections 18-point terminal block	

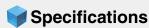
Channel isolated analog input module

Item		Q68AD-G
No. of analog input points		8 points (8 channels)
Analog	Voltage	0 to 5 V DC, 1 to 5 V DC, 0 to 10 V DC, -10 to 10 V DC, user range
input	Current	0 to 20 mA DC, 4 to 20 mA DC, user range
Absolute max	. input	±15 V, ±30 mA
Digital	High resolution mode	0 to 16000 (0 to 10 V DC), 0 to 12000 (0 to 5 V DC, 1 to 5 V DC; 0 to 20 mA DC, 4 to 20 mA DC), -16000 to 16000 (-10 to 10 V DC), -12000 to 12000 (user range)
output	Normal resolution mode	0 to 4000 (0 to 10 V DC, 0 to 5 V DC, 1 to 5 V DC; 0 to 20 mA DC, 4 to 20 mA DC) -4000 to 4000 (-10 to 10 V DC, user range)
Accuracy (accuracy to max. digital output value)	Reference accuracy	±0.1% High resolution mode (0 to 10 V, -10 to 10 V): ±16 digits High resolution mode (other than the above ranges): ±12 digits Normal resolution mode: ±4 digits
value)	Temperature coefficient	±71.4 ppm/°C (0.00714%/°C)
Sampling cycle		10 ms/channel
Isolation method		Transformer
No. of occupied I/O points		16 points (I/O assignment: Intelligent 16 points)
External connections		40-pin connector

Channel isolated analog input module (with signal conditioning function)

	Item		Item	Q66AD-DG	
_	ations	No. of analog input points (no. of 2-wire transmitters) Analog input		6 points (6 channels)	
2-wire transmitter connection	Input specific			4 to 20 mA DC (input resistance: 250 Ω), user range (0 to 20 mA DC without 2-wire transmitter)	
smitte	ply	Supp	ly voltage	26±2 V DC	
e tran	Power supply specifications	Max.	supply current	24 mA DC	
2-wir	Pov	Short-circuit protection		Yes (limit current: 25 to 35 mA)	
	Check terminals			Yes	
Dig	High resolution mode			0 to 12000	
out	put Normal resolution mode			0 to 4000	
(acc	Accuracy (accuracy to max.		Reference accuracy	±0.1% High resolution mode: ±12 digits Normal resolution mode: ±4 digits	
valu		Temperature coefficient		±71.4 ppm/°C (0.00714%/°C)	
Sa	Sampling cycle		le	10 ms/channel	
Iso	Isolation method		nod	Transformer	
No	. of c	ccupi	ed I/O points	16 points (I/O assignment: Intelligent 16 points)	
Ext	External connections		nections	40-pin connector	

MELSEC Process Control Products



Channel isolated analog output module

Item		Q62DA-FG
No. of analog output points		2 points (2 channels)
Digital input	· ·	16-bit signed binary (-12288 to 12287, -16384 to 16383)
Analog output	Voltage	-12 to 12 V DC (external load resistance: 1 k to 1 MΩ)
Analog output	Current	0 to 20 mA DC (external load resistance: 0 to 600 Ω)
Analog output	Voltage	1 to 5 V DC, 0 to 5 V DC, -10 to 10 V DC, user range setting 2, user range setting 3
range	Current	0 to 20 mA DC, 4 to 20 mA DC, user range setting 1
Accuracy	Reference accuracy	±0.1% (voltage: ±10 mV, current: ±20 μA)
(accuracy to max. analog output value)	Temperature coefficient	±80 ppm/°C (0.008%/°C)
Conversion speed		10 ms/2 channels
Absolute max.	Voltage	±13 V
output	Current	23 mA
	Resolution	12 bits
Output monitor	Reference accuracy	±0.2%
	Temperature coefficient	±160 ppm/°C (0.016%/°C)
Short-circuit prote	ection	Yes
Isolation method		Between I/O terminal and programmable controller power supply: Photocoupler Between analog output channels: Transformer Between external power supply and analog output channel: Transformer
No. of occupied I	O points	16 points (I/O assignment: Intelligent 16 points)
External connections		18-point terminal block

Item		Q66DA-G	
No. of analog output points		6 points (6 channels)	
Digital input		16-bit signed binary (high resolution mode: -12288 to 12287, -16384 to 16383; normal resolution mode: -4096 to 4095)	
Analag autnut	Voltage	-12 to 12 V DC (external load resistance: 1 k to 1 MΩ)	
Analog output	Current	0 to 20 mA DC (external load resistance: 0 to 600 Ω)	
Analog output	Voltage	1 to 5 V DC, 0 to 5 V DC, -10 to 10 V DC, user range setting 2, user range setting 3	
range	Current	0 to 20 mA DC, 4 to 20 mA DC, user range setting 1	
Accuracy	Reference accuracy	±0.1% (voltage: ±10 mV, current: ±20 μA)	
(accuracy to max. analog output value)	Temperature coefficient	±80 ppm/°C (0.008%/°C)	
Conversion speed	t	6 ms/channel	
Absolute max.	Voltage	±13 V	
output	Current	23 mA	
Short-circuit prote	ection	Yes	
Isolation method		Between output terminal and programmable controller power supply: Transformer Between analog output channels: Transformer Between external power supply and analog output channel: Transformer	
No. of occupied I/	O points	16 points (I/O assignment: Intelligent 16 points)	
External connecti	ons	40-pin connector	

Channel isolated thermocouple/micro voltage input module and thermocouple input module

Item		Q64TDV-GH	Q64TD	Q68TD-G-H02	
No. of channels		4 cha	nnels	8 channels	
Output Temperature conversion value		16-bit signed bi	gned binary (-2700 to 18200: Each increment represents 0.1°C change)		
·	Scaling value		16-bit signed binary		
Thermocou	uple standards	JIS C16	IIS C1603 1005 IEC 60594 1 (1005)		
	rmocouples and e measurement range		0°C, R: -50 to 1760°C, S: -50 to 1760°C, K: -270 to 100°C, J: -210 to 1200°C, T: -270 to 400°C, N: -270		
Micro volta	ge input range	-100 to 100 mV (input resistance: 2 $\text{M}\Omega$ or more)	N/A		
	on temperature ion accuracy	±1.0°C			
Conversion	n speed	Sampling cycle x 3	40 ms/channel	640 ms/8 channels	
Sampling of	cycle	20 ms/channel	N/A		
No. of anal	og input points	(4 channels + Pt100 con	connection channel)/module (8 channels + Pt100 connection chan		
Isolation me	ethod	Between th	rmocouple input/micro voltage input and ground: T ermocouple input/micro voltage input channels: Tr on temperature compensation input (Pt100) and gr	ansformer	
Disconnection detection		Yes (each channel independently)		Yes	
No. of writes to E ² PROM		Max. 100,	Max. 100,000 times		
No. of write	es to flash memory	N/	A	Max. 50,000 times	
No. of occupied I/O points			16 points (I/O assignment: Intelligent 16 points)		
External connections		18-point ten	minal block	40-pin connector	

Channel isolated pulse input module

Item			QD60P8-G
Counting	Counting speed switch settings		30 kpps/10 kpps/1 kpps/100 pps/50 pps/10 pps/0.1 pps
No. of ch	nannels		8 channels
Count in	nput signal	Phase	1 phase
Countin		Signal level	5 V DC/12 to 24 V DC
	Counting speed (max.)		30 kpps/10 kpps/10 kpps/100 pps/50 pps/10 pps/1 pps/0.1 pps
Counter	Counting	ı range	Sampling pulse number: 16-bit binary (0 to 32767) Accumulating count value: 32-bit binary (0 to 99999999) Input pulse value: 32-bit binary (0 to 2147483647)
	Count type		Linear counter method, ring counter method
No. of oc	No. of occupied I/O points		32 points (I/O assignment: Intelligent 32 points)
External connections		ns	18-point terminal block

Channel isolated RTD input module

Item			Q64RD-G	Q68RD3-G	
No. of channels			4 channels	8 channels	
Output	Temperature conversion value		16-bit signed binary(-2000 to 8500: Each increment represents 0.1°C change), 32-bit signed binary(-200000 to 850000: Each increment represents 0.001°C change)	16-bit signed binary (-2000 to 8500: Each increment represents 0.1°C change)	
	Scaling value		16-bit signed binary		
Measuring method (wire type)		d (wire type)	3-/4-wire type	3-wire type	
			Pt100 (JIS C1604-1997, IEC 751 1983) Temperature measurement range: -200 to 850°C		
Usable RTD			JPt100 (JIS C1604-1981) Temperature measurement range: -180 to 600°C		
			Ni100 (DIN43760 1987) Temperature measurement range: -60 to 180°C		
		-200 to 850°C	±0.553°C (25±5°C), ±1.615°C (0 to 55°C)	±0.8°C (25±5°C), ±2.4°C (0 to 55°C)	
	Pt100	-20 to 120°C	±0.090°C (25±5°C), ±0.300°C (0 to 55°C)	±0.3°C (25±5°C), ±1.1°C (0 to 55°C)	
		0 to 200°C	±0.145°C (25±5°C), ±0.470°C (0 to 55°C)	±0.4°C (25±5°C), ±1.2°C (0 to 55°C)	
Accuracy	JPt100	-180 to 600°C	±0.390°C (25±5°C), ±1.140°C (0 to 55°C)	±0.8°C (25±5°C), ±2.4°C (0 to 55°C)	
		-20 to 120°C	±0.090°C (25±5°C), ±0.300°C (0 to 55°C)	±0.3°C (25±5°C), ±1.1°C (0 to 55°C)	
		0 to 200°C	±0.145°C (25±5°C), ±0.470°C (0 to 55°C)	±0.4°C (25±5°C), ±1.2°C (0 to 55°C)	
	Ni100	-60 to 180°C	±0.135°C (25±5°C), ±0.450°C (0 to 55°C)	±0.4°C (25±5°C), ±1.2°C (0 to 55°C)	
Resolution			0.025°C	0.1°C	
Conversion speed		d	40 ms/channel	320 ms/8 channels	
No. of analog input points		ut points	4 channels/module	8 channels/module	
Isolation method			Between RTD input and programmable controller power supply: Photocoupler Between RTD input channels: Transformer	Between RTD input and programmable controller power supply: Transformer Between RTD input channels: Transformer	
Disconnection detection		tection	Yes (each channel independently)		
No. of occupied I/O points		O points	16 points (I/O assignment: Intelligent 16 points)		
External connections		ons	18-point terminal block	40-pin connector	

Temperature control module

Item	Q64TCTT	Q64TCTTBW	Q64TCRT	Q64TCRTBW	
Control output	Transistor output				
No. of temperature input point	4 channels/module				
Usable thermocouples/ platinum RTDs	Thermocouple (R, K, J, T, S, B, E, N, U, L, PL II, W5Re/W26Re)		Platinum RTD (Pt100, JPt100)		
Accuracy	Ambient temperature of 25 \pm 5°C: Full scale x (\pm 0.3%) Ambient temperature of 0 to 55°C: Full scale x (\pm 0.7%)				
Sampling cycle	0.5 s/4 channels				
PID constant range	Proportional band (P): 0.0 to 1000.0% Integral time (I): 1 to 3600 s Derivative time (D): 0 to 3600 s				
Isolation method	Between input and ground: Transformer Between input and channel: Transformer				
Heater disconnection detection	No	Yes	No	Yes	
No. of occupied I/O points	16 points (I/O assignment: Intelligent 16 points)	32 points/2 slots (Default I/O assignment: Empty 16 points [first half], Intelligent 16 points [second half])	16 points (I/O assignment: Intelligent 16 points)	32 points/2 slots (Default I/O assignment: Empty 16 points [first half], Intelligent 16 points [second half])	
External connections	18-point terminal block	Two 18-point terminal blocks	18-point terminal block	Two 18-point terminal blocks	

Load cell

Item	Q61LD				
Analog input (load cell output) points	1 point (1 channel)				
Analog input (load cell output)	0.0 to 3.3mV/V				
Load cell applied voltage	5VDC ±5%, Output current within 60mA (Four 350Ω load cells can be connected in parallel.) 6-wire system (Combination use of remote sensing method and ratiometric method)				
Digital output	32-bit signed binary 0 to 10000				
Gross weight output (Maximum weighing output value)	32-bit signed binary -99999 to 99999 (excluding decimal point and unit symbol)				
Analog input range (load cell rated output)	0.0 to 1.0mV/V, 0.0 to 2.0mV/V, 0.0 to 3.0mV/V				
I/O characteristics, Maximum resolution	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				
Accuracy (Accuracy relative to analog input (load cell rated output) of a module)	Nonlineality: Within ±0.01%/FS (Ambient temperature 25°C) Zero drift: Within ±0.25 μV/°C RTI Gain drift: Within ±15 ppm/°C				
Conversion speed	10 ms				
Absolute maximum input	±2.5V				
Insulation method	Photocoupler insulation				
No. of occupied I/O points	16 points (I/O assignment: intelligent 16 points)				
External connections	18-point terminal block				



PX Developer



PX Developer screen configuration and screen examples



Programming tool

Project window

The project parameters, applicable modules, tags, program names, execution cycle, etc. are set in this window.

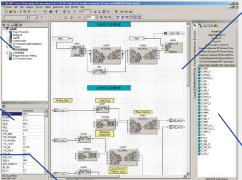
FB property window

The initial values of the data in the FB are set in this window.

Sheet

Maximum 32 sheets/program

Screen configuration



Program/FB definition window

The programs and user defined FBs are created in this window.

A program is a unit in which the process is described. Up to 200 programs can be created. One program contains up to 32 sheets. A sheet is a form used to paste FB/functions or connector lines and to describe the process.

FB/function part window

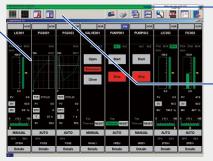
The FB/function parts which can be pasted to the programs and user defined FBs are displayed in this window.

Monitor tool

Monitor function display area

Each monitor function (control panel, trend graph, faceplate, tuning panel, alarm list, or event list) is displayed in this area.

Screen configuration



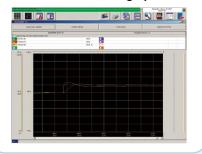
Alarm/event display area

The latest two alarms or event messages are displayed.

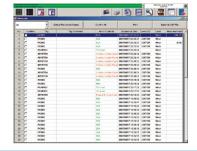
Tool bar

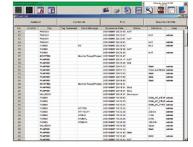
Icons that call out each monitor function are displayed.

Historical trend graph



Event/alarm list





Process control monitoring screen generator

The PX Developer Monitor tool can generate process control monitoring screens for GOT from process control programs created by the programming tool. Also, graphic screens can be configured by combining the following optional tools with the Monitor tool.



The graphics screen can be created at a low price with the SoftGOT drawing tool.



Highly flexible graphic screens can be created using VB language. MX Component facilitates communication with the process CPU.



Graphics screen can be created enough by commercially available SCADA.



Example of graphic screen creation tool





Features

Substantial FBs (function blocks) and functions for loop control

- · In addition to the process CPU's loop control instruction FBs, PX Developer has combined FBs that are easy to use.
- · Basic FB/functions (logical operation, arithmetic operation, etc.) that comply with IEC61131-3 are also provided, allowing simple sequence control to be described in the FBD.

Easy programming with FBs/process tag names

- The loop control program can be created easily. Select the required FBs from the PX Developer's standard loop control FB or compensation FB, paste and connect them on the screen, and then set the parameters such as the PID constants and upper/lower limits (items configuring tags).
- · When programming with tag names, the parameters in the tag can be described as "tag name.parameter name" (FIC001.PV, etc.). This enables the user to program without having to concern about the device memory addresses.

Analog/digital I/O processing in FB

· FBs for I/O processing of the analog and I/O modules controlled by the process CPU are equipped. Ladder programs for I/O processing are no longer required.

Easy to standardize and reuse programs

· PX Developer complies with the IEC61131-3 standards. Programs can be modularized (custom FB can be created). This allows for reuse in future projects requiring similar capabilities, greatly reducing development time.

Program event execution

· FBD programs can be executed not only periodically but also automatically upon event occurrence. (The event conditions can be described without a program.) PX Developer easily realizes the starting process for nonstationary, error, and exceptional processes.

Integration with sequence control programs

- · Easy data exchange with ladder programs.
- · Data can be exchanged between the FBD program and ladder program (created with GX Developer) using logical names (labels) instead of device memory addresses. Therefore, constants of loop control tags, SV values, etc. can be easily changed from the ladder programs.

Uploading/downloading FBD programs

- Graphic data of FBD programs can be stored in the programmable controller CPU by writing.
- · The stored data can be recovered by reading from the programmable controller CPU. Therefore, the program can be edited with a PC in which the project is not stored.

Comprehensive tuning and monitoring functions

- · The PX Developer has various screens (face plate, tuning trend, alarm, event list, etc.) used to tune, monitor, and operate the created control loop. Tuning and monitoring are available immediately after creating the program.
- · Auto tuning can be used by the Step Response method or the Limit Cycle method.

Combination with SoftGOT

· Using together with SoftGOT, process control monitoring screens can be readily created. P.37 P.42

Improved operability for redundant system

Users can design the redundant system without repeating the same procedure for the control and standby systems, reducing the total setup and design time.

Supports the server/client monitoring system

- · Easy to use by utilizing the Monitor tool.
- · Configuring the server/client monitoring system with lower cost is possible.
- · Supports the large process control systems.

Engineering Environment



PX Developer





Specifications

Programming tool

Item	Specifications
Target CPU	Process CPU (Q02PHCPU/Q06PHCPU/Q12PHCPU/Q25PHCPU) Redundant CPU (Q12PRHCPU/Q25PRHCPU)
Target network	CC-Link IE Controller Network, MELSECNET/H, MELSECNET/10 (Note 1), Ethernet (10/100 Mbps), RS232 (CPU's RS-232 port), USB (CPU's USB port)
Programming languages	IEC61131-3 compliant FBD language
Number of programs	Max. 200 (max. 32 sheets/program)
Number of tags	Max. 120/process CPU (Q02/06PHCPU) Max. 480/process CPU (Q12/25PHCPU, Q12/25PRHCPU)
FB/function types	General functions: 58 types (IEC61131-3 compliant basic functions) General FB: 20 types (IEC61131-3 compliant basic FB) Process functions: 5 types (corresponding to process instructions for CPU) General process FB: 28 types (corresponding to process instructions for CPU) Tag access FB: 37 types (corresponding to process instructions for CPU) Tag FB: 46 types (high function FBs with temperature control function by combining process FBs) Module FB: 31 types (FBs for accessing Q Series analog and I/O modules)
Program execution method	Timer execution type: scan executed at high speed (200 ms cycle), normal speed (200/400/600/800 ms/1 s cycle), or low speed (1/2/4/5/10 s cycle). Interrupt execution type: cycle interrupt (1 to 999 ms) or random interrupt (interrupt with interrupt pointer I0 to I255) (in practical use, 10 ms or more/control loop)

Note 1) When An, AnS, QnA, QnAS, and Q4AR CPUs are mixed on the network, the target network is MELSECNET/10 PLC to PLC network.

Monitor tool

	Item	Specifications	
Target CPU and network		· Same as the programming tool	
Number of monitoring CPU modules and tags		 Number of process CPUs under monitoring: Max. 16 (Max. 16 process CPUs can be monitored from one PC.) Number of monitor tags: Max. 7,680 For the redundant system, a pair of CPUs (control and standby systems) is counted as one CPU. 	
Monitor functions	Control panel	8 faceplates/screen (one group) x max. 500 screens = 4,000 faceplates Lockout tag available for each faceplate	
	Trend graph	8 items/screen (one group) x max. 125 screens = 1,000 items Collection cycle: 1 s/10 s/1 min./5 min./10 min. The chart can be output into a CSV file. Automatically generated CSV files can be opened in the trend graph display.	
	Alarm list	Max. 2,000 alarms can be displayed. The list can be output into a CSV file.	
	Event list	Max. 2,000 events can be displayed. The list can be output into a CSV file.	
	User application	· Max. 4 can be started.	
	Tag data external I/F	· The faceplate can be displayed, monitored, and operated on an external application by using ActiveX faceplate button or faceplate control.	
	GOT screen generator function	· Process control monitoring screens for GOT1000 can be automatically generated from process control programs created by the programming tool. (Max.120 tags)	

Application example: Fluid level control

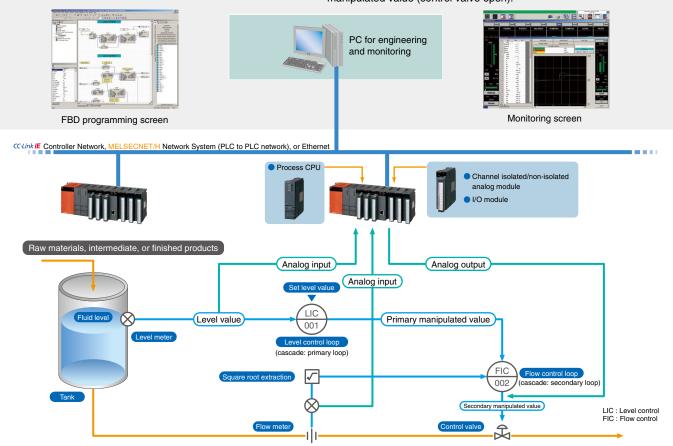
Application

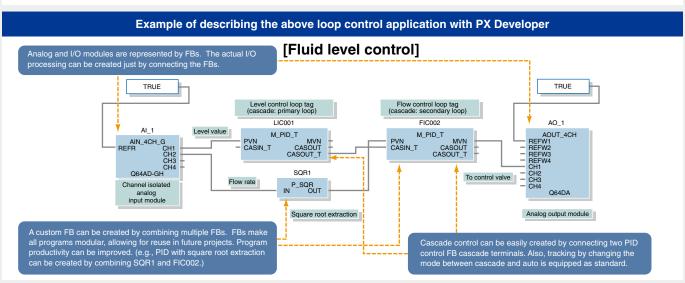
The MELSEC process control system can be used to control fluid level at food and chemical plants. Fluid level of raw materials, intermediate products, and finished products in the tank can be maintained within the set range.

Control details

The level control loop (cascade: primary loop) inputs the tank level (analog value) and implements PI operation to achieve the set level value.

The flow control loop (cascade: secondary loop) uses the operation result (primary manipulated value) of the level control loop as the set value and implements PI operation with the flow rate from the flow meter. The result is output as an analog value to the control valve, which is the secondary manipulated value (control valve open).







PX Developer



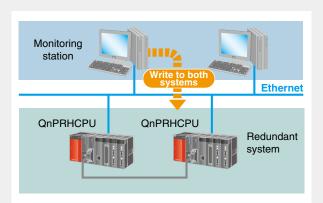
Redundant system related functions (Programming tool)

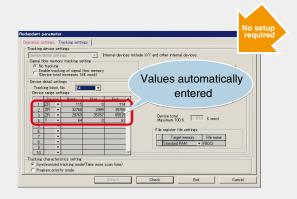
Simple engineering environment

All tag information and programs are managed in a single project; programs and parameters are downloaded to both systems, just like a single system. No special consideration for redundancy is required, reducing engineering time.

No tracking setting required

Device tracking settings in PX Developer are automatically generated by compiling, reducing setup time.





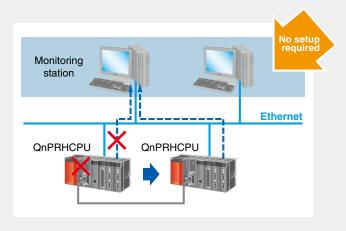
Redundant system related functions (Monitor tool)

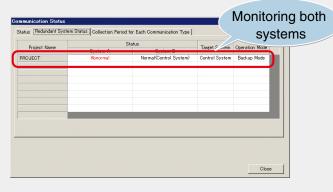
Easy to monitor

By setting the control system as the monitoring target in the transfer setup, the new control system is automatically monitored when the system is switched. No extra setting is required for system switching.

Monitoring redundant system communication status

Both systems in the redundant system are monitored; the status of each system (control/standby) and communication errors are displayed.

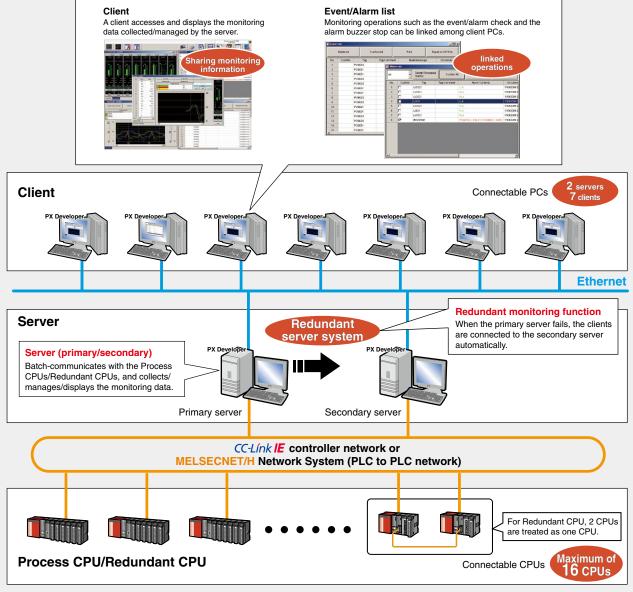




Server/client monitoring system(monitor tool)

Supporting large-scaled process control system. Easy and low-cost system configuration.

- · With the server/client monitoring system, the monitoring information is shared and the monitoring operations are linked.
- · Even with the expansion of monitoring PCs, the communication load with programmable controllers is controlled by the server-clients configuration to maintain the monitoring operation performance.



Item	Specifications		
Connectable PC	2 servers(primary/secondary) Maximum of 7 clients		
Compatible CPU	Process CPU (Q02PHCPU, Q06PHCPU, Q12PHCPU, Q25PHCPU) Redundant CPU (Q12PRHCPU, Q25PRHCPU) Connectable CPUs:Maximum of 16		
Compatible network	CC-Link IE controller network, MELSECNET/H/(10) network system, Ethernet		
Function overview	A server performs communication with PLCs in a batch, so communication loads on PLCs can be reduced and communication performance can be improved. The monitoring data collected/managed by a server can be displayed on clients. In other words, the same monitor screen can be displayed with the monitor tool on every OPS. Installing a primary server and a secondary server in the monitoring system enables continuous monitoring when an error occurs in the primary server, for clients switch the server to connect automatically. When an operation, such as a buzzer stop and check/deletion of an alarm/event, is performed in one of OPSs in the monitoring system, its result synchronizes in every OPS in the monitoring system.		

Engineering Environment



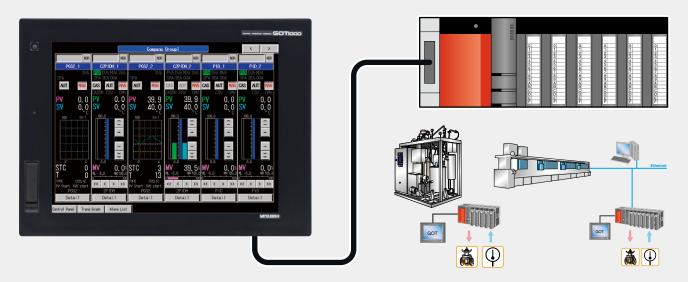
PX Developer



GOT screen generator function

Equipment/shop floor monitoring by GOT1000

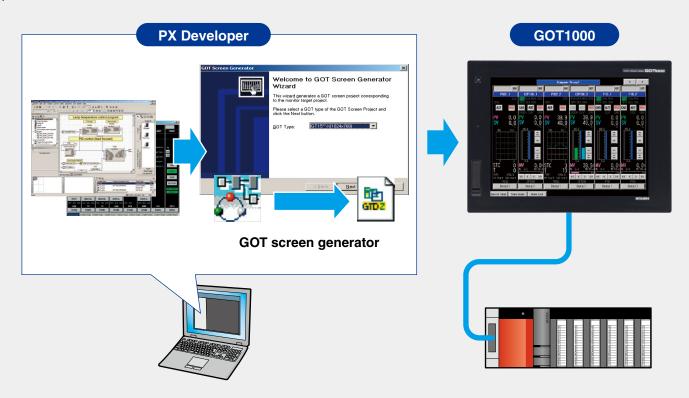
GOT1000 can be used for monitoring equipment and shop floor.



Easy to create GOT1000 process control monitoring screens

- \cdot Faceplates and tuning screens for GOT1000 can be automatically generated from PX Developer projects.
- \cdot Tag's assigned device settings or programs are not needed for the auto-generated screens.
- *Only CPU which is connected to the host station can be monitored.

 Multiple CPUs which are connected to other stations cannot be monitored.

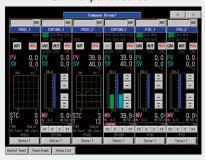


The following screens can be generated with the GOT screen generator function.

Faceplate



Control panel screen



Trend graph screen





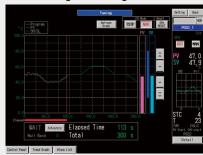
Alarm list screen



Tuning screen



Program setting screen



ltem	Specifications
Supported CPU	Process CPU (Q02PHCPU, Q06PHCPU, Q12PHCPU, Q25PHCPU), Redundant CPU (Q12PRHCPU, Q25PRHCPU)
Supported GOT	GT15: Each model of XGA and SVGA GT16: Each model of XGA and SVGA GT SoftGOT1000 (screen size: 1024 x 768 dot [XGA], 800 x 600 dot [SVGA] only)
Supported screen design software (Note 1) (Note 2)	GT Designer2 Version 2.82L or later: Q02PHCPU, Q06PHCPU GT Designer2 Version 2.73B or later: Q12PHCPU, Q25PHCPU, Q12PRHCPU, Q25PRHCPU
Functions (outline)	Number of generable tags: Max. 120 (loop tags and status tags) Generable screens: Faceplate, control panel, and detailed screens (tuning screen, setting screen, alarm list screen, and trend graph screen) Number of faceplates on control panel: 8/screen (XGA), 6/screen (SVGA) Connection path: One-to-one connection between GOT1000 and target CPU (host station) ▶ Process CPU: CPU direct connection, bus connection, computer link connection, Ethernet connection ▶ Redundant CPU: Computer link connection, Ethernet connection (Refer to user's manual for details) Tuning trend cycle: 1 s or more

Note 1) GT Designer2 is required to use the GOT generator function.

Note 2) For GT16, changing GOT type with GT Designer2 after generating in GOT15 enables generated screens to be used in GT16.



Software supporting redundant system





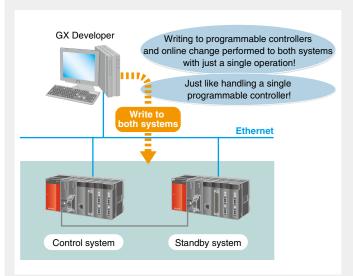
🔰 GX Developer

GX Developer is a comprehensive programming tool that improves work efficiency in development, debugging, and maintenance of programmable controllers. To support the redundant system, it provides dedicated parameter settings and functions such as online program download to both systems (control/standby).

Easy to modify programs

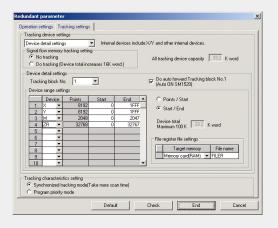
Using the following functions, programs can be written to both control and standby systems simultaneously. These functions simplify program modifications, cutting down development time.

- Writing programs and parameter files to programmable controllers
- Online change (editing and writing programs to the programmable controllers while online)



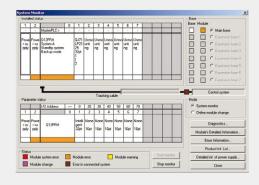
Simple parameter settings for the redundant system

The redundant system settings such as tracking settings, which maintain device status of both systems consistent, are designed in a familiar format to GX Developer users.



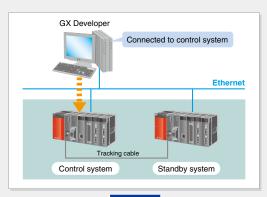
Monitoring module errors

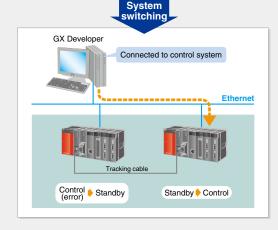
The status of the CPUs, intelligent function modules, and redundant power supply modules can be monitored. Hence, faulty modules can be quickly identified.



Continuous operation even at system switching

In the event of system switching due to a stop error in the CPU, the access target will be automatically switched. The operation continues smoothly, freeing the operator from having to consider system switching.







Software supporting redundant system



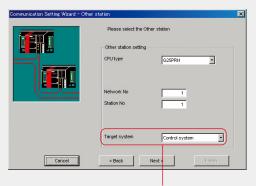


MX Component

MX Component is an ActiveX control library that supports all communication paths, from the PC to the programmable controller, and enables communications by simple processing. User applications can be easily configured without having to concern about system switching.

Simple communication settings

Selecting "Control system" as the target system makes the redundant system available: all other communication settings are the same as the standard system.



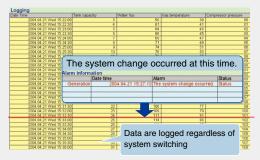
Select "Control system" for the redundant system.

Utilization of existing software

Existing user applications created with MX Component can be used for the redundant system simply by changing the communication settings.

Supports the redundant system

MX Sheet enables monitoring, logging, etc. of the programmable controller system using Excel without programming. It runs by MX Components, supporting the redundant system.

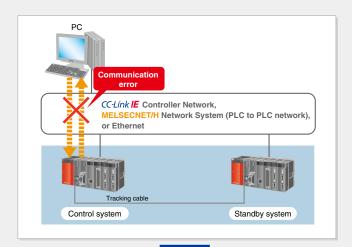


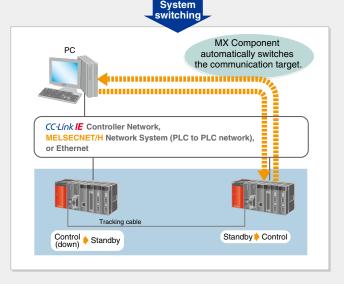
Simplifies troubleshooting after system switching

MX Component constantly monitors some of the redundant CPU devices. Hence, it is easy to know whether the currently-accessed CPU is a control system or standby system. When the system is switched, diagnostics and troubleshooting can be performed using GX Developer.

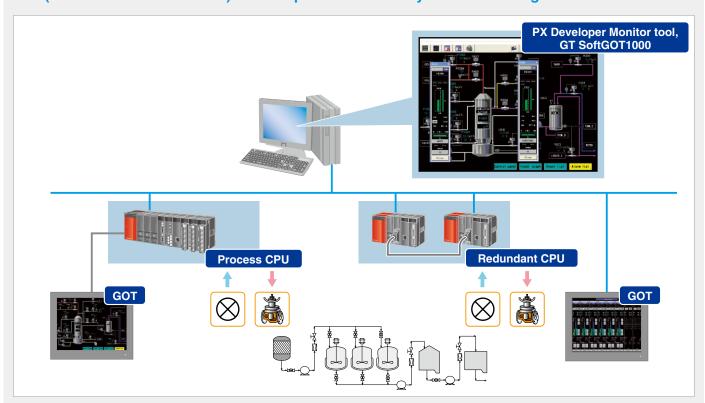
Easy programming

The redundant system application can be programmed without being conscious of the redundancy. When system switching occurs due to a control system failure, communication is automatically continued with the new control system switched from the standby system. Programming is not required to switch the communication target, reducing development time.





HMI (human machine interface) enables process control system monitoring.





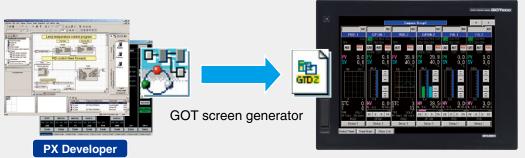


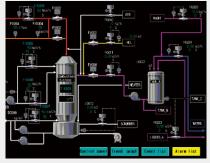


Usable at various sites

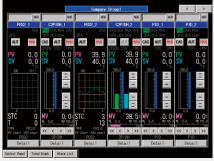
The PX Developer's GOT screen generator function facilitates monitoring screen generation for GOT1000.

GOT1000









Graphic screen

PID loop control tuning screen

Control panel



GT SoftGOT1000



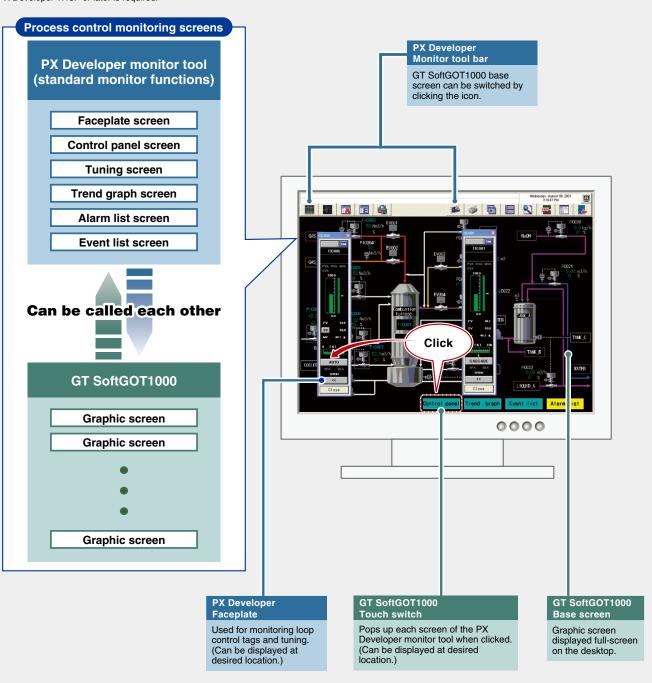


Features

Easy to create process control monitoring screen

- · The standard monitor functions of PX Developer monitor tool can be called from the graphic screen of GT SoftGOT1000 and vice versa^(Note 1), dramatically reducing screen designing time.
- \cdot Can be used on a PC. It is best suited for monitoring at the office.
- \cdot GOT1000 screens can be utilized, reducing time for creating new screens.

Note 1) PX Developer 1.13P or later is required.



Extensive global support coverage providing expert help whenever needed

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■ EMEA

Europe FA Center

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Czech Republic FA Center

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Italy FA Center

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Thailand FA Center

MITSUBISHI ELECTRIC FACTORY AUTOMATION (THAILAND) CO., LTD.

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ASEAN FA Center

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Malaysia FA Center

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Philippines FA Center

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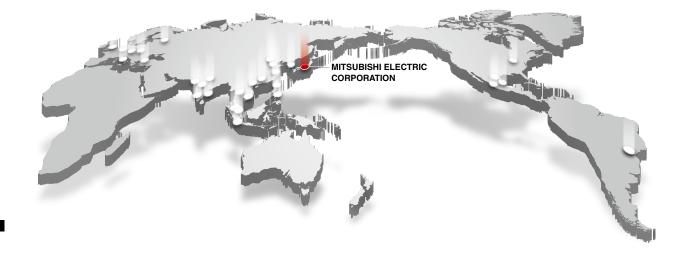
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Brazil FA Center

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Factory Automation Global website

Mitsubishi Electric Factory Automation provides a mix of services to support its customers worldwide.

A consolidated global website is the main portal, offering a selection of support tools and a window to its local Mitsubishi Electric sales and support network.

■ From here you can find:

- Overview of available factory automation products
- · Library of downloadable literature
- Support tools such as online e-learning courses, terminology dictionary, etc.
- Global sales and service network portal
- Latest news related to Mitsubishi Electric factory automation

Mitsubishi Electric Factory Automation Global website:

www.MitsubishiElectric.com/fa



Online e-learning

An extensive library of e-learning courses covering the factory automation product range has been prepared. Courses from beginner to advanced levels of difficulty are available in various languages.



■ Beginner level

Designed for newcomers to Mitsubishi Electric Factory Automation products gaining a background of the fundamentals and an overview of various products related to the course.

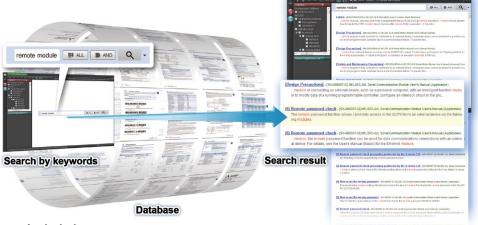
■ Basic to Advanced levels

These courses are designed to provide education at all levels. Various different features are explained with application examples providing an easy and informative resource for in-house company training.

Innovative next-generation, e-Manual

e-Manual Viewer

The e-Manual viewer is a next-generation digital manual offered by Mitsubishi Electric that consolidates factory automation products manuals into an easy-to-use package with various useful features integrated into the viewer. The e-Manual allows multiple manuals to be cross-searched at once, further reducing time for setting up products and troubleshooting.



■ Key features included

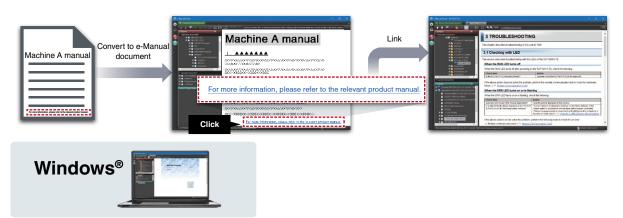
- One-stop database containing all required manuals, with local file cache
- Included with GX Works3 engineering software
- Also available in tablet version
- Easily download manuals all at once

- Multiple users can share the latest manuals and knowhow with document sharing function
- Directly port sample programs within manuals to GX Works3
- Downloaded manuals are usable offline



e-Manual Create

e-Manual Create is software for converting word files and chm files to e-Manual documents. e-Manual Create allows users to directly refer to Mitsubishi Electric e-Manuals from user's customized device maintenance manuals and such, supporting quick troubleshooting and reduction in document creation process.



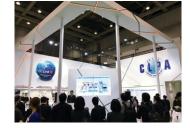
^{*} To obtain the Windows® version of e-Manual Viewer and e-Manual Create, please contact your local Mitsubishi Electric sales office or representative

CC-Link Partner Association (CLPA) - Actively promoting worldwide adoption of CC-Link networks

Proactively supporting CC-Link, from promotion to specification development

The CC-Link Partner Association (CLPA) was established to promote the worldwide adoption of the CC-Link open-field network. By conducting promotional activities such as organizing trade shows and seminars, conducting conformance tests, and providing catalogs, brochures and website information, CLPA activities are successfully increasing the number of CC-Link partner manufacturers and CC-Link-compatible products. As such, CLPA is playing a major role in the globalization of CC-Link.







Seminar

Trade show

Conformance testing lab

Visit the CLPA website for the latest CC-Link information.

URL:www.cc-link.org



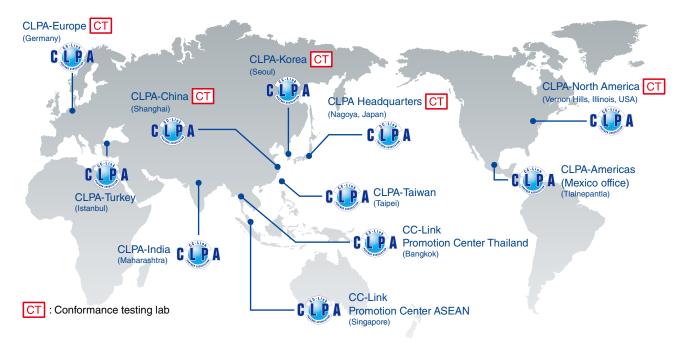
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e-mail: info@cc-link.org



Global influence of CC-Link continues to spread

CC-Link is supported globally by CLPA. With offices throughout the world, support for partner companies can be found locally.

Each regional CLPA office undertakes various support and promotional activities to further the influence of CC-Link/CC-Link IE in that part of the world. For companies looking to increase their presence in their local area, CLPA is well placed to assist these efforts through offices in all major regions.



CPU, power supply

Pro	duct	Model	Outline
		Q00UJCPU	No. of I/O points: 256 points, no. of I/O device points: 8192 points, program capacity: 10 k steps, basic operation processing speed (LD instruction): 0.12 μ s, program memory capacity: 40 KB, peripheral connection ports: USB and RS232, no memory card I/F, 5-slot base, with 100 to 240 V AC input / 5 V DC/3 A output power supply
		Q00UCPU	No. of I/O points: 1024 points, no. of I/O device points: 8192 points, program capacity: 10 k steps, basic operation processing speed (LD instruction): 0.08 μ s, program memory capacity: 40 KB, peripheral connection ports: USB and RS232, no memory card I/F
		Q01UCPU	No. of I/O points: 1024 points, no. of I/O device points: 8192 points, program capacity: 15 k steps, basic operation processing speed (LD instruction): 0.06 μ s, program memory capacity: 60 KB, peripheral connection ports: USB and RS232, no memory card I/F
		Q02UCPU	No. of I/O points: 2048 points, no. of I/O device points: 8192 points, program capacity: 20 k steps, basic operation processing speed (LD instruction): 0.04 μ s, program memory capacity: 80 KB, peripheral connection ports: USB and RS232, with memory card I/F
		Q03UDCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 30 k steps, basic operation processing speed (LD instruction): 0.02 µs, program memory capacity: 120 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
Universal mod QCPU	el	Q04UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 40 k steps, basic operation processing speed (LD instruction): $0.0095 \mu s$, program memory capacity: 160 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q06UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 60 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 240 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q10UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 100 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 400 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q13UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 130 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 520 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q20UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 200 k steps, basic operation processing speed (LD instruction): 0.0095 μ s, program memory capacity: 800 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q26UDHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 260 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 1040 KB, multiple CPU high-speed communication, peripheral connection ports: USB and RS232, with memory card I/F
		Q03UDECPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 30 k steps, basic operation processing speed (LD instruction): $0.02~\mu s$, program memory capacity: 120 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q04UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 40 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 160 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q06UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 60 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 240 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q10UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 100 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 400 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
	Built-in Ethernet type	Q13UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 130 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 520 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q20UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 200 k steps, basic operation processing speed (LD instruction): 0.0095 μ s, program memory capacity: 800 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q26UDEHCPU	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 260 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: $1040~KB$, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q50UDEHCPU NEW	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 500 k steps, basic operation processing speed (LD instruction): 0.0095 μ s, program memory capacity: 2000 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q100UDEHCPU NEW	No. of I/O points: 4096 points, no. of I/O device points: 8192 points, program capacity: 1000 k steps, basic operation processing speed (LD instruction): $0.0095~\mu s$, program memory capacity: 4000 KB, multiple CPU high-speed communication, peripheral connection ports: USB and Ethernet, with memory card I/F
		Q00JCPU	No. of I/O points: 256 points, no. of I/O device points: 2048 points, program capacity: 8 k steps, basic operation processing speed (LD instruction): 0.2 μ s, program memory capacity: 58 KB, peripheral connection ports: RS232, no memory card I/F, 5-slot base, with 100 to 240 V AC input / 5 V DC/3 A output power supply
Basic model QCPU		Q00CPU	No. of I/O points: 1024 points, no. of I/O device points: 2048 points, program capacity: 8 k steps, basic operation processing speed (LD instruction): 0.16 μ s, program memory capacity: 94 KB, peripheral connection ports: RS232, no memory card I/F
		Q01CPU	No. of I/O points: 1024 points, no. of I/O device points: 2048 points, program capacity: 14 k steps, basic operation processing speed (LD instruction): 0.1 μ s, program memory capacity: 94 KB, peripheral connection ports: RS232, no memory card I/F

^{*}Always refer to user's manuals for information on usable modules, restrictions, etc. before using.
*Contact your local Mitsubishi sales office or representative for the latest information on the MELSOFT versions and compatible OS.

CPU, power supply

A 12PHCPU In controller CPU Openins 4096 points, no. of I/O device points; 8192 points, program capacity; 496 KB, peripheral connection points; USB and RS222, with memory capacity; 496 KB, peripheral connection points; USB and RS222, with heaving capacity; 496 KB, basic operation processing speed (LD instruction); 0.034 ps, program capacity; 252 k steps, basic operation processing speed (LD instruction); 0.034 ps, program capacity; 252 k steps, basic operation processing speed (LD instruction); 0.034 ps, program capacity; 252 k steps, basic operation processing speed (LD instruction); 0.034 ps, program capacity; 252 k steps, basic operation profession professions; 0.014 pp. 400 pp. 4	Product		Model	Outline
Description or common model OCPU Descri			Q02CPU	basic operation processing speed (LD instruction): 0.079 µs, program memory capacity: 112 KB,
testic operations processing speed LD Instructions (10.034)s, program memory capacity; 240 KB, perphase all commission ports (10.58 and 18.522) with memory card of VE operations (10.05 and 18.522) with memory card of VE operations (10.05 and 18.522) with memory card of VE operations (10.05 and 18.05 and 18.522) with memory card (10.05 kB), perphased commercion ports (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.58 and 18.523) with memory card (10.05 kB), perphased commercion ports; (10.05			Q02HCPU	basic operation processing speed (LD instruction): 0.034 μ s, program memory capacity: 112 KB,
Committee CPU Display operation processing speed LD instruction; 0.034/s, program region youngeoity, 486 KR, peripheral committed prost USB and RSS22, with memory capacity, 256 KR, peripheral committed prosts. USB and RSS22, with memory capacity, 256 K steps, between committees and processing speed LD instruction; 0.034/s, program capacity, 258 k steps, between committees and resident processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention sports; USB and RSS23, with memory capacity 258 k steps, peripheral convention sports; USB and RSS23, with memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention processing speed LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention positions general LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention positions general LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention positions general LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention positions general LD instruction; 0.034/s, program memory capacity, 258 k steps, peripheral convention positions general LD instruction; 0.034/s, program memory capac	High Performance mo	odel QCPU	Q06HCPU	basic operation processing speed (LD instruction): 0.034 \mus, program memory capacity: 240 KB,
Desire CPU			Q12HCPU	basic operation processing speed (LD instruction): 0.034 µs, program memory capacity: 496 KB,
DOZPHCPU Dissis-Coparation processing speed (LD instructions) 0.034µs, program memory capacity, 112 KB, peripheral connection ports; USB and Res222, with memory card UF			Q25HCPU	basic operation processing speed (LD instruction): 0.034 μ s, program memory capacity: 1008 KB,
OBENICPU basic operation processing speed (L) Instruction; 0.034µs, program memory capacity; 240 KB, peripheral connection ports: USB and Res222, with memory cand UF Committee Com			Q02PHCPU	basic operation processing speed (LD instruction): 0.034µs, program memory capacity: 112 KB,
No. of I/O points, 4096 points, no. of I/O device points; 8192 points, program capacity; 124 k steps, peripheral connection ports; USB and RS222, with memory card UF. C25PHCPU			Q06PHCPU	basic operation processing speed (LD instruction): 0.034 \mus, program memory capacity: 240 KB,
Description processing speed (LD instruction); 0.034µs, program memory capout; 1.008 KB, peripheral connection ports. USB and RSS23, with memory card LFP	Process CPU		Q12PHCPU	basic operation processing speed (LD instruction): 0.034 μ s, program memory capacity: 496 KB,
Packundant CPU Desis operation processing speed (LD instruction): 0.034µs, pergram memory capacity; 496 KB, peripheral connection ports: USB and R5232, with memory card IVF			Q25PHCPU	basic operation processing speed (LD instruction): 0.034 μ s, program memory capacity: 1008 KB,
Description	Padundant CDL		Q12PRHCPU	basic operation processing speed (LD instruction): 0.034 μ s, program memory capacity: 496 KB,
Tracking cable OC30TR Tracking cable 3 m Tracking cable 6 m Tracking c	Redundant CPO		Q25PRHCPU	basic operation processing speed (LD instruction): 0.034 \mus, program memory capacity: 1008 KB,
C Controller CPU Controller CPU Con	T	-1-1	QC10TR	Tracking cable 1 m
A Controller CPU OGCCPU-V OGCCPU-V No. of I/O points: 4096 points, endian format: little endian, removable storage: CF card, OS:VxWorks Version 5. Ordina (GT05-MEM-128MC, Mess 2) GT05-MEM-256MC (GT05-MEM-256MC (Ress 2) GT05-MEM-256MC (Ress 2) GT05-MEM-256MC (Ress 2) GT05-MEM-256MC (Ress 2) GT05-MEM-256MC (Ress 2) GD81 MEM-4512MBC (Ress 2) GD82 MEM-4512MBC (Ress 2) GD83 MEM-4512MBC (Ress 2) GD84 MEM-4512MBC (R	Irac	cking cable	QC30TR	Tracking cable 3 m
Option Option	Controller CDL		Q12DCCPU-V	No. of I/O points: 4096 points, endian format: little endian, removable storage: CF card, OS:VxWorks Version 6.4
GT05-MEM-128MC GT05-MEM-266MC GT05-MEM-266MC GT05-MEM-266MC GT05-MEM-266MC GT05-MEM-266MC GT05-MEM-266MC GT05-MEM-512MBC GD81MEM-512MBC GD81MEM-16BC GD81MEM-16BC GD81MEM-46BC GB8AT GReplacement large-capacity battery G7BAT-SET Large-capacity battery with holder for mounting CPU G8BAT G8BAT-SET Large-capacity battery module with CPU connection cable G2MEM-1MBS GAMEM-1MBS GAMEM-4MBS GAME	C Controller CPU		Q06CCPU-V	No. of I/O points: 4096 points, endian format: little endian, removable storage: CF card, OS:VxWorks Version 5.4
Option Option			Q12DCCPU-CB (Note 1)	RS-232 connection converter cable (custom mini-DIN to 9-pin D-sub connector)
Option Option			(Note 2)	128 MB CompactFlash card
QB81MEM-1GBC 1 GB CompactFlash card QD81MEM-2GBC (**Death 1) 2 GB CompactFlash card QD81MEM-4GBC (**Death 1) 3 GB CompactFlash card QD81MEM-4GBC (**Death 1) 4 GB CompactFlash card QD81MEM-8GBC (**Death 1) 5 GB CompactFlash card QB81MEM-8GBC (**Death 1) 8 GB CompactFlash card QB8AT Replacement battery Q7BAT Replacement large-capacity battery Q7BAT Replacement large-capacity battery Q7BAT Replacement large-capacity battery module QB8AT Replacement large-capacity battery module QB8AT Replacement large-capacity battery module QB8AT SET Large-capacity battery module with CPU connection cable Q2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS SRAM memory card, capacity: 8 MB Q3MEM-8MBS SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBF SET SRAM memory card, capacity: 8 MB Q2MEM-8MBF Linear Flash memory card, capacity: 8 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-3MBA ATA card, capacity: 9 MB Q2MEM-3DBA ATA card, capacity: 9 MB Q2MEM-3DBA ATA card, capacity: 9 MB Q2MEM-3DBA ATA card, capacity: 16 MB Q2MEM-3DBA ATA card, capacity: 10 MB Q2MEM-3DBA ATA card, capacit			GT05-MEM-256MC (Note 2)	256 MB CompactFlash card
QD81MEM-2GBC Notes 1) 2 GB CompactFlash card	Op	otion	QD81MEM-512MBC	
OD81MEM-4GBC (Notes 1) 4 GB CompactFlash card OD81MEM-8GBC (Notes 1) 8 GB CompactFlash card GBBAT Replacement battery O7BAT Replacement large-capacity battery O7BAT-SET Large-capacity battery with holder for mounting CPU OBBAT Replacement large-capacity battery module OBBAT Replacement large-capacity battery module OBBAT Replacement large-capacity battery module OBBAT-SET Large-capacity battery module with CPU connection cable Q2MEM-1MBS SRAM memory card, capacity: 1 MB OZMEM-2MBS SRAM memory card, capacity: 2 MB OZMEM-2MBS SRAM memory card, capacity: 2 MB OZMEM-4MBS SRAM memory card, capacity: 4 MB OZMEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB OZMEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB OZMEM-4MBF Linear Flash memory card, capacity: 2 MB OZMEM-4MBF Linear Flash memory card, capacity: 2 MB OZMEM-4MBB ATA card, capacity: 8 MB OZMEM-3MBA ATA card, capacity: 16 MB OZMEM-3BMBA ATA card, capacity: 16 MB OZMEM-3CMBA ATA card, capacity: 32 MB Memory card adapter OZMEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot OZMEM-BAT Replacement battery for Q2MEM-1MBS and Q3MEM-8MBS OZMEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS OCONNECTION DEVIATION OF THE CONNECTION OF THE CONNE				1 GB CompactFlash card
QD81MEM-8GBC (Plots 1) 8 GB CompactFlash card				2 GB CompactFlash card
Battery OBAT Replacement battery Q7BAT Replacement large-capacity battery Q7BAT Replacement large-capacity battery O7BAT-SET Large-capacity battery with holder for mounting CPU Q8BAT Replacement large-capacity battery module Q8BAT-SET Large-capacity battery module with CPU connection cable Q2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-18MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-16MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS G3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				4 GB CompactFlash card
Battery Part				8 GB CompactFlash card
Battery O7BAT-SET Large-capacity battery with holder for mounting CPU O8BAT Replacement large-capacity battery module Q8BAT-SET Large-capacity battery module with CPU connection cable O2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS-SET SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-3MBA ATA card, capacity: 8 MB Q2MEM-3BMBA ATA card, capacity: 8 MB Q2MEM-3BMBA ATA card, capacity: 16 MB Q2MEM-3DP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable OCSIR2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q8BAT Replacement large-capacity battery module Q8BAT-SET Large-capacity battery module with CPU connection cable Q2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-16MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-3DP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable Q23ME2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q8BAT-SET Large-capacity battery module with CPU connection cable Q2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 8 MB Q2MEM-32MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)	Battery			
Q2MEM-1MBS SRAM memory card, capacity: 1 MB Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS-SET SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS RAM card battery Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q2MEM-2MBS SRAM memory card, capacity: 2 MB Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-16MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q3MEM-4MBS SRAM memory card, capacity: 4 MB Q3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB Q3MEM-8MBS SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-16MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
O3MEM-4MBS-SET SRAM memory card with cover, capacity: 4 MB O3MEM-8MBS SRAM memory card, capacity: 8 MB O3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB O3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB O2MEM-2MBF Linear Flash memory card, capacity: 2 MB O2MEM-4MBF Linear Flash memory card, capacity: 4 MB O2MEM-8MBA ATA card, capacity: 8 MB O2MEM-16MBA ATA card, capacity: 16 MB O2MEM-32MBA ATA card, capacity: 32 MB O2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter O2MEM-ADP Adapter for O2MEM memory card's standard PCMCIA slot O2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS O3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable OC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Memory card Q3MEM-8MBS SRAM memory card, capacity: 8 MB Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS RSAM card battery Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Memory card Q3MEM-8MBS-SET SRAM memory card with cover, capacity: 8 MB Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q2MEM-2MBF Linear Flash memory card, capacity: 2 MB Q2MEM-4MBF Linear Flash memory card, capacity: 4 MB Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)	Mamon			
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Q2MEM-8MBA ATA card, capacity: 8 MB Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)	Memory card adapter			
Q2MEM-16MBA ATA card, capacity: 16 MB Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q2MEM-32MBA ATA card, capacity: 32 MB Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Memory card adapter Q2MEM-ADP Adapter for Q2MEM memory card's standard PCMCIA slot Q2MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
SRAM card battery Q2MEM-BAT Q3MEM-BAT Replacement battery for Q2MEM-1MBS and Q2MEM-2MBS Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
SRAM card battery Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)				
Q3MEM-BAT Replacement battery for Q3MEM-4MBS and Q3MEM-8MBS Connection cable QC30R2 RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P) Cable disconnection	SRAM card battery	,		
Cable disconnection				
Cable disconnection			QC30R2	RS-232 cable for connecting personal computer and CPU, 3 m (between mini-DIN6P and Dsub9P)
Q6HLD-R2 Holder for prevention holder Holder for prevention holder	Cable disconnection	on	Q6HLD-R2	Holder for preventing RS-232 cable (programmable controller CPU connection) disconnection

Base

Product	Model	Outline
	Q33B	3 slots, 1 power supply module required, for Q Series modules
Main base	Q35B	5 slots, 1 power supply module required, for Q Series modules
IVIdii i Dase	Q38B	8 slots, 1 power supply module required, for Q Series modules
	Q312B	12 slots, 1 power supply module required, for Q Series modules
Multiple CPU high speed	Q38DB	8 slots, 1 power supply module required, for Q Series modules
main base	Q312DB	12 slots, 1 power supply module required, for Q Series modules
	Q32SB	2 slots, 1 slim type power supply module required, for Q Series modules
Slim type main base	Q33SB	3 slots, 1 slim type power supply module required, for Q Series modules
	Q35SB	5 slots, 1 slim type power supply module required, for Q Series modules
Redundant power main base	Q38RB	8 slots, 2 redundant power supply modules required, for Q Series modules
	Q63B	3 slots, 1 power supply module required, for Q Series modules
	Q65B	5 slots, 1 power supply module required, for Q Series modules
Futancian base	Q68B	8 slots, 1 power supply module required, for Q Series modules
Extension base	Q612B	12 slots, 1 power supply module required, for Q Series modules
	Q52B	2 slots, power supply module not required, for Q Series modules
	Q55B	5 slots, power supply module not required, for Q Series modules
Redundant power extension base	Q68RB	8 slots, 2 redundant power supply modules required, for Q Series modules
Redundant type extension base	Q65WRB (Note 1)	5 slots, 2 redundant power supply modules required, for Q Series modules
	QC05B	0.45 m cable for connecting extension base unit
	QC06B	0.6 m cable for connecting extension base unit
Extension cable	QC12B	1.2 m cable for connecting extension base unit
Extension cable	QC30B	3 m cable for connecting extension base unit
	QC50B	5 m cable for connecting extension base unit
	QC100B	10 m cable for connecting extension base unit
	Q6DIN1	DIN rail mounting adapter for Q38B, Q312B, Q68B, Q612B, Q38RB, Q68RB, Q65WRB, Q38DB, and Q312DB
DIN roll mounting adopter	Q6DIN2	DIN rail mounting adapter for Q35B, Q65B, and Q00UJCPU
DIN rail mounting adapter	Q6DIN3	DIN rail mounting adapter for Q32SB, Q33SB, Q35SB, Q33B, Q52B, Q55B, and Q63B
	Q6DIN1A	DIN rail mounting adapter (with vibration-proofing bracket set) for Q3_B, Q5_B, Q6_B, Q38RB, Q68RB, and Q65WRB
Blank cover	QG60	Blank cover for I/O slot

Note 1) Only compatible with redundant CPU system.

Power supply

	Q61P	Input voltage: 100 to 240 V AC, output voltage: 5 V DC, output current: 6 A
Dower ownh	Q62P	Input voltage: 100 to 240 V AC, output voltage: 5/24 V DC, output current: 3/0.6 A
Power supply	Q63P	Input voltage: 24 V DC, output voltage: 5 V DC, output current: 6 A
	Q64PN	Input voltage: 100 to 240 V AC, output voltage: 5 V DC, output current: 8.5 A
Power Supply with Life Detection	Q61P-D	Input voltage: 100 to 240 V AC, output voltage: 5 V DC, output current: 6A
Slim type power supply	Q61SP	Input voltage: 100 to 240 V AC, output voltage: 5 V DC, output current: 2 A
Dadundant naugraumalu	Q63RP	Input voltage: 24 V DC, output voltage: 5 V DC, output current: 8.5 A
Redundant power supply	Q64RP	Input voltage: 100 to 120/200 to 240 V AC, output voltage: 5 V DC, output current: 8.5 A

I/O module

F	Product	Model	Outline	
		QX10	16 points, 100 to 120 V AC, response time: 20 ms, 16 points/common, 18-point terminal block	
	AC	QX10-TS	16 points, 100 to 120 V AC, response time: 20 ms, 16 points/common, 18-point spring clamp terminal block	
		QX28	8 points, 100 to 240 V AC, response time: 20 ms, 8 points/common, 18-point terminal block	
		QX40	16 points, 24 V DC, response time: 1/5/10/20/70 ms, 16 points/common, positive common, 18-point terminal block	
		QX40-TS	16 points, 24 V DC, response time: 1/5/10/20/70 ms, 16 points/common, positive common, 18-point spring clamp terminal block	
		QX40-S1	16 points, 24 V DC, response time: 0.1/0.2/0.4/0.6/1 ms, 16 points/common, positive common, 18-point terminal block	
	DC	QX40H	16 points, 24 V DC, response time: 0/0.1/0.2/0.4/0.6/1 ms, 8 points/common, positive common, 18-point terminal block	
	(Positive	QX41 (Note 2) (Note	oz pointo, za v zo, response time. 1767 to 267 to me, ez pointo, comment, positive comment,	
	common) (Note 1)	QX41-S1 (Note	32 points, 24 V DC, response time: 0.1/0.2/0.4/0.6/1 ms, 32 points/common, positive common, 40-pin connector	
		QX41-S2 NEW (Note 2) (Note	32 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive common, 40-pin connector	
		QX42 (Note	64 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive common, 40-pin connector	
		QX42-S1 (Note	64 points, 24 V DC, response time: 0.1/0.2/0.4/0.6/1 ms, 32 points/common, positive common, 40-pin connector	
Input	AC/DC	QX50	16 points, 48 V AC/DC, response time: 20 ms, 16 points/common, positive/negative common, 18-point terminal block	
		QX70	16 points, 5/12 V DC, response time: 1/5/10/20/70 ms, 16 points/common, positive/negative common, 18-point terminal block	
	DC sensor	QX70H	16 points, 5 V DC, response time: 0/0.1/0.2/0.4/0.6/1 ms, 8 points/common, positive common, 18-point terminal block	
		QX71 (Note	32 points, 5/12 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive/negative common, 40-pin connector	
		QX72 (Note	64 points, 5/12 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive/negative common, 40-pin connected	
		QX80	16 points, 24 V DC, response time: 1/5/10/20/70 ms, 16 points/common, negative common, 18-point terminal block	
		QX80-TS	16 points, 24 V DC, response time: 1/5/10/20/70 ms, 16 points/common, negative common, 18-point spring clamp terminal block	
		QX80H	16 points, 24 V DC, response time: 0/0.1/0.2/0.4/0.6/1 ms, 8 points/common, negative common, 18-point terminal bloc	
	DC (Negative	QX81 (Note 3) (Note	⁴⁾ 32 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, negative common, 37-pin D-sub connector	
	common) (Note 1)	QX81-S2 NEW (Note 3) (Note	32 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, negative common, 37-pin D-sub connector	
		QX82 (Note	64 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, negative common, 40-pin connector	
		QX82-S1 (Note	2) 64 points, 24 V DC, response time: 0.1/0.2/0.4/0.6/1 ms, 32 points/common, negative common, 40-pin connector	
		QX90H	16 points, 5 V DC, response time: 0/0.1/0.2/0.4/0.6/1 ms, 8 points/common, negative common, 18-point terminal block	
		QY10	16 points, 24 V DC/240 V AC, 2 A/point, 8 A/common, response time: 12 ms, 16 points/common, 18-point terminal block	
	Relay	QY10-TS	16 points, 24 V DC/240 V AC, 2 A/point, 8 A/common, response time: 12 ms, 16 points/common, 18-point spring clamp terminal block	
		QY18A	8 points, 24 V DC/240 V AC, 2 A/point, response time: 12 ms, 18-point terminal block, all points independent	
	Triac	QY22	16 points, 100 to 240 V AC, 0.6 A/point, 4.8 A/common, response time: 1 ms + 0.5 cycle, 16 points/common, 18-point terminal block, with surge suppressor	
		QY40P	16 points, 12 to 24 V DC, 0.1 A/point, 1.6 A/common, response time: 1 ms, 16 points/common, sink type, 18-point terminal block, with overload protection function and overheat protection function and surge suppressor	
		QY40P-TS	16 points, 12 to 24 V DC, 0.1 A/point, 1.6 A/common, response time: 1 ms, 16 points/common, sink type, 18-point spring clamp terminal block, with overload protection function and overheat protection function and surge suppress	
	Transistor (Sink)	QY41P (Note	32 points, 12 to 24 V DC, 0.1 A/point, 2 A/common, response time: 1 ms, 32 points/common, sink type, 40-pin connector, with overload protection function and overheat protection function and surge suppressor	
		QY42P (Note	40-pin connector, with overload protection function and overheat protection function and surge suppressor	
Output		QY50	16 points, 12 to 24 V DC, 0.5 A/point, 4 A/common, response time: 1 ms, 16 points/common, sink type, 18-point terminal block, with surge suppressor and fuse	
	Transistor (Independent)	QY68A	8 points, 5 to 24 V DC, 2 A/point, 8 A/module, response time: 10 ms, sink/source type, 18-point terminal block, with surge suppressor, all points independent	
	TTL CMOS	QY70	16 points, 5 to 12 V DC, 16 mA/point, 256 mA/common, response time: 0.5 ms, 16 points/common, sink type, 18-point terminal block, with fuse	
		QY71 (Note 2)	32 points, 5 to 12 V DC, 16 mA/point, 512 mA/common, response time: 0.5 ms, 32 points/common, sink type, 40-pin connector, with fuse	
		QY80	16 points, 12 to 24 V DC, 0.5 A/point, 4 A/common, response time: 1 ms, 16 points/common, source type, 18-point terminal block, with surge suppressor and fuse	
	Transistor	QY80-TS	16 points, 12 to 24 V DC, 0.5 A/point, 4 A/common, response time: 1 ms, 16 points/common, source type, 18-point spring clamp terminal block, with surge suppressor and fuse	
	(Source)	QY81P (Note 3)	32 points, 12 to 24 V DC, 0.1 A/point, 2 A/common, response time: 1 ms, 32 points/common, source type, 37-pin D-sub connector, with overload protection function and overheat protection function and surge suppressor	
		QY82P NEW (Note	64 points, 12 to 24 V DC, 0.1 A/point, 2 A/common, response time: 1 ms, 32 points/common, source type, 40-pin connector, with overload protection function and overheat protection function and surge suppressor	

Note 1) "Positive common" indicates that the positive lead of a DC power supply must be connected to the common terminal. Accordingly, "Negative common" indicates that the negative lead must be connected to the common terminal.

Note 2) Connector is not provided. Separately order one of the following: A6CON1/A6CON2/A6CON3/A6CON4.

Note 3) Connector is not provided. Separately order one of the following: A6CON1E/A6CON2E/A6CON3E.

Note 4) The rated input currents are different. [QX41: approx. 4 mA, QX41-S2: approx. 6 mA, QX81: approx. 4 mA, QX81-S2: approx. 6 mA]

Product List

I/O module

Pro	duct	Model	Outline
		QH42P (Note 1) (Note 2)	Input: 32 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive common, output: 32 points, 12 to 24 V DC, 0.1 A/point, 2 A/common, response time: 1 ms, 32 points/common, sink type, 40-pin connector, with overload protection function and overheat protection function and surge suppressor
1/0	DC input/ transistor output	QX48Y57	Input: 8 points, 24 V DC, response time: 1/5/10/20/70 ms, 8 points/common, positive common, output: 7 points, 12 to 24 V DC, 0.5 A/point, 2 A/common, response time: 1 ms, 7 points/common, sink type, 18-point terminal block, with surge suppressor and fuse
		QX41Y41P (Note 1) (Note 2)	Input: 32 points, 24 V DC, response time: 1/5/10/20/70 ms, 32 points/common, positive common, output: 32 points, 12 to 24 V DC, 0.1 A/point, 2 A/common, response time: 1 ms, 32 points/common, sink type, 40-pin connector, with overload protection function and overheat protection function and surge suppressor
Interrupt modu	le	Q160	16 point, 24 V DC, response time: 0.1/0.2/0.4/0.6/1 ms, 16 points/common, 18-point terminal block
		A6CON1	32-point connector soldering type (40-pin connector)
		A6CON2	32-point connector crimp-contact type (40-pin connector)
		A6CON3	32-point connector pressure-displacement (flat cable) type (40-pin connector)
Connector		A6CON4	32-point connector soldering type (40-pin connector, cable connectable in bidirection)
		A6CON1E	32-point connector soldering type (37-pin D-sub connector)
		A6C0N2E	32-point connector crimp-contact type (37-pin D-sub connector)
		A6CON3E	32-point connector pressure-displacement (flat cable) type (37-pin D-sub connector)
Spring clamp	erminal block	Q6TE-18S	For 16-point I/O modules, 0.3 to 1.5 mm ² (22 to 16 AWG)
Terminal block	adapter	Q6TA32	For 32-point I/O modules, 0.5 mm ² (20 AWG)
Tominal bloor		Q6TA32-TOL	Q6TA32 dedicated tool
		A6TBXY36	For positive common input modules and sink output modules (standard type)
		A6TBXY54	For positive common input modules and sink output modules (2-wire type)
		A6TBX70	For positive common input modules (3-wire type)
Connector/ter		А6ТВХЗ6-Е	For negative common input modules (standard type)
conversion mo	dule	A6TBX54-E	For negative common input modules (2-wire type)
		А6ТВХ70-Е	For negative common input modules (3-wire type)
		А6ТВҮЗ6-Е	For source output modules (standard type)
		A6TBY54-E	For source output modules (2-wire type)
		AC05TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 0.5 m
		AC10TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 1 m
		AC20TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 2 m
		AC30TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 3 m
		AC50TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 5 m
	Cable	AC80TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 8 m *Common current 0.5 A or lower
	Cabic	AC100TB	For A6TBXY36, A6TBXY54, and A6TBX70 (positive common/sink type), 10 m *Common current 0.5 A or lower
		AC05TB-E	For A6TBX36-E, A6TBY36-E, A6TBX54-E, A6TBY54-E, and A6TBX70-E (negative common/source type), 0.5 m
		AC10TB-E	For A6TBX36-E, A6TBX36-E, A6TBX54-E, A6TBY54-E, and A6TBX70-E (negative common/source type), 1 m
		AC20TB-E	For A6TBX36-E, A6TBX36-E, A6TBX54-E, A6TBY54-E, and A6TBX70-E (negative common/source type), 2 m
		AC30TB-E	For A6TBX36-E, A6TBY36-E, A6TBX54-E, A6TBY54-E, and A6TBX70-E (negative common/source type), 3 m
		AC50TB-E	For A6TBX36-E, A6TBX54-E, A6TBX54-E, and A6TBX70-E (negative common/source type), 5 m
Relay terminal	module	A6TE2-16SRN	For 40-pin connector 24 V DC transistor output modules (sink type)
		AC06TE	For A6TE2-16SRN, 0.6 m
		AC10TE	For A6TE2-16SRN, 1 m
	Cable	AC30TE	For A6TE2-16SRN, 3 m
		AC50TE	For A6TE2-16SRN, 5 m
		AC100TE	For A6TE2-16SRN, 10 m

Note 1) A connector is not provided. Order one of the following separately: A6CON1/A6CON2/A6CON3/A6CON4.

Note 2) The number of occupied input/output points is different. [QH42P: 32 points; QX41Y41P: 64 points (first 32 points: input / second 32 points: output)]

Analog I/O module

Prod	duct	Model	Outline	
	Voltage input	Q68ADV	8 channels, input: -10 to 10 V DC, output (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, 0 to 16000, -16000 to 16000, conversion speed: 80 µs/channel, 18-point terminal block	
		Q62AD-DGH	2 channels; input, 4 to 20 mA DC, output (resolution): 0 to 32000, 0 to 64000, conversion speed: 10 ms/2 channels, 18-point terminal block, channel isolated, supplies power to 2-wire transmitter	
	Current input	Q66AD-DG (Note 1)	6 channels, input: 4 to 20 mA DC (when 2-wire transmitter is connected), 0 to 20 mA DC, output (resolution): 0 to 4000, 0 to 12000, conversion speed: 10 ms/channel, 40-pin connector, channel isolated, supplies power to 2-wire transmitter	
Analog input		Q68ADI	8 channels, input: 0 to 20 mA DC, output (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, 0 to 16000, -16000 to 16000, conversion speed: 80 μ s/channel, 18-point terminal block	
		Q64AD	4 channels; input -10 to 10 V DC, 0 to 20 mA DC, output (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, 0 to 16000, -16000 to 16000, conversion speed: 80 µs/channel, 18-point terminal block	
	Voltage/ current input	Q64AD-GH	4 channels, input: -10 to 10 V DC, 0 to 20 mA DC, output (resolution): 0 to 32000, -32000 to 32000, 0 to 64000, -64000 to 64000, conversion speed: 10 ms/4 channels, 18-point terminal block, channel isolated	
		Q68AD-G (Note 1)	8 channels, input: -10 to 10 V DC, 0 to 20 mA DC, output (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, 0 to 16000, -16000 to 16000, conversion speed: 10 ms/channel, 40-pin connector, channel isolate	
	Voltage output	Q68DAVN	8 channels, input (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, -16000 to 16000, output: -10 to 10 V DC, conversion speed: 80 µs/channel, 18-point terminal block, transformer isolation between power supply and output	
	Current output	Q68DAIN	8 channels, input (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000; output: 0 to 20 mA DC, conversion speed: 80 μ s/channel, 18-point terminal block, transformer isolation between power supply and output	
Analog		Q62DAN	2 channels, input (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, -16000 to 16000, output: -10 to 10 V DC, 0 to 20 mA DC, conversion speed: 80 μ s/channel, 18-point terminal block, transformer isolation between power supply and output	
output	Voltage/	Q62DA-FG	2 channels, input (resolution): 0 to 12000, -12000 to 12000, -16000 to 16000, output: -12 to 12 V DC, 0 to 22 mA DC, conversion speed: 10 ms/2 channels, 18-point terminal block, channel isolated	
	current output	Q64DAN	4 channels, input (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, -16000 to 16000, output: -10 to 10 V DC, 0 to 20 mA DC, conversion speed: $80~\mu s$ /channel, 18-point terminal block, transformer isolation between power supply and output	
		Q66DA-G (Note 1)	6 channels, input (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, -16000 to 16000, output: -12 to 12 V DC, 0 to 22 mA DC, conversion speed: 6 ms/channel, 40-pin connector, channel isolated	
Analog input/ output	Voltage and current input/ output	Q64AD2DA NEW	Input: 4 channels Input: -10 to 10 V DC, 0 to 20 mA DC Output (resolution): 0 to 4000, -4000 to 4000, 0 to 12000, -12000 to 12000, 0 to 16000, -16000 to 16000 Conversion speed: 500 µs/channel Output: 2 channels Input (resolution): 0 to 4000,-4000 to 4000,0 to 12000,-16000 to 16000 Output: -10 to 10 V DC, 0 to 20 mA DC Conversion speed: 500 µs/channel 18-point terminal block	
Load cell input		Q61LD NEW	1 channel, input (load cell output): 0.0 to 3.3 mV/V, output (resolution): 0 to 10000, conversion speed: 10 ms, 18-point terminal bloom	
		Q64RD	4 channels, platinum RTD (Pt100 [JIS C1604-1997, IEC 751 1983], JPt100 [JIS C1604-1981]), conversion speed: 40 ms/channel, 18-point terminal block	
	RTD	Q64RD-G	4 channels, RTD (Pt100 [JIS C1604-1997, IEC 751 1983], JPt100 [JIS C1604-1981], Ni100 Ω [DIN43760 1987]), conversion speed: 40 ms/channel, 18-point terminal block, channel isolated	
_		Q68RD3-G (Note 1)	8 channels, RTD (3-wire type, Pt100 [JIS C1604-1997, IEC 751 1983], JPt100 [JIS C1604-1981]), Ni100 Ω [DIN43760 1987]), conversion speed: 320 ms/8 channels, 40-pin connector, channel isolated	
Temperature input		Q64TD	4 channels, thermocouple (JIS C1602-1995), conversion speed: 40 ms/channel, 18-point terminal block	
·		Q64TDV-GH	4 channels, thermocouple (JIS C1602-1995), micro voltage (-100 to 100 mV), conversion speed: sampling cycle x 3, sampling cycle: 20 ms/channel, 18-point terminal block	
	Thermocouple	Q68TD-G-H01 (Note 1) (Note 2)	8 channels, thermocouple (JIS C1602-1995, IEC 60584-1 [1995], IEC 60584-2 [1982]), conversion speed: 320 ms/8 channels, 40-pin connector	
		Q68TD-G-H02 (Note 1)	8 channels, thermocouple (JIS C1602-1995, IEC 60584-1 [1995], IEC 60584-2 [1982]), conversion speed: 640 ms/8 channels, 40-pin connector	
Temperature control	Platinum RTD	Q64TCRT	4 channels, platimum RTD (Pt100, JPt100), no heater disconnection detection, sampling cycle: 0.5 s/4 channels, 18-point terminal block	
	radinam m D	Q64TCRTBW	4 channels, platimum RTD (Pt100, JPt100), with heater disconnection detection, sampling cycle: 0.5 s/4 channels, two 18-point terminal blocks	
	Thermocouple	Q64TCTT	4 channels, thermocouple (K, J, T, B, S, E, R, N, U, L, PLII, W5Re/W26Re), no heater disconnection detection, sampling cycle: 0.5 s/4 channels, 18-point terminal block	
	rnemocouple	Q64TCTTBW	4 channels, thermocouple (K, J, T, B, S, E, R, N, U, L, PLII, W5Re/W26Re), with heater disconnection detection, sampling cycle: 0.5 s/4 channels, two 18-point terminal blocks	
Loop control		Q62HLC	2 channels, input: thermocouple/micro voltage/voltage/current, conversion speed (input): 25 ms/2 channels, sampling cycle: 25 ms/2 channels; output: 4 to 20 mA DC, conversion speed (output): 25 ms/2 channels; 18-point terminal block, with 5 PID control modes	

Note 1) A connector is not provided. The A6CON4 connector must be ordered separately.

Note 2) The number of modules that can be installed is restricted based on the combination of power supply and base unit.

Product List

Pulse I/O and positioning module

Product		Model		Outline
Channel isolated pulse input		QD60P8-G		8 channels, 30 kpps/10 kpps/1 kpps/100 pps/50 pps/10 pps/1 pps/0.1 pps, count input signal: 5/12 to 24 V DC
		QD62	(Note 1)	2 channels, 200/100/10 kpps, count input signal: 5/12/24 V DC, external input: 5/12/24 V DC, coincidence output: transistor (sink), 12/24 V DC, 0.5 A/point, 2 A/common, 40-pin connector
		QD62D	(Note 1)	2 channels, 500/200/100/10 kpps, count input signal: EIA standards RS-422-A (differential line driver), external input: 5/12/24 V DC; coincidence output: transistor (sink), 12/24 V DC, 0.5 A/point, 2 A/common, 40-pin connector
High-speed co	ounter	QD62E	(Note 1)	2 channels, 200/100/10 kpps, count input signal: 5/12/24 V DC, external input: 5/12/24 V DC, coincidence output: transistor (source), 12/24 V DC, 0.1 A/point, 0.4 A/common, 40-pin connector
		QD63P6	(Note 2)	6 channels, 200/100/10 kpps, count input signal: 5 V DC, 40-pin connector
		QD64D2 NEW	(Note 2)	2 channels, 4 Mpps, count input signal: EIA standards RS-422-A (differential line driver), external input: 24 V DC, coincidence output: transistor (sink), 12/24 V DC, 0.5 A/point, 2 A/common, 40-pin connector
		QD75P1	(Note 2)	1 axis, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 200 kpps, 40-pin connector
	Open collector	QD75P2	(Note 2)	2 axes, 2-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 200 kpps, 40-pin connector
	output	QD75P4	(Note 2)	4 axes, 2-/3-/4-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 200 kpps, 40-pin connector
		QD70P4	(Note 2)	4 axes, control unit: pulse, no. of positioning data: 10/axis, max. output pulse: 200 kpps, 40-pin connector
		QD70P8	(Note 2)	8 axes, control unit: pulse, no. of positioning data: 10/axis, max. output pulse: 200 kpps, 40-pin connector
		QD75D1	(Note 2)	1 axis, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 1 Mpps, 40-pin connector
	Differential	QD75D2	(Note 2)	2 axes, 2-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 1 Mpps, 40-pin connector
	output	QD75D4	(Note 2)	4 axes, 2-/3-/4-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, max. output pulse: 1 Mpps, 40-pin connector
		QD70D4	(Note 2)	4 axes, control unit: pulse, no. of positioning data: 10/axis, max. output pulse: 4 Mpps, 40-pin connector
		QD70D8	(Note 2)	8 axes, control unit: pulse, no. of positioning data: 10/axis, max. output pulse: 4 Mpps, 40-pin connector
Positioning		QD75M1	(Note 1)	1 axis, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector
	With SSCNET connectivity	QD75M2	(Note 1)	2 axes, 2-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector
		QD75M4	(Note 1)	4 axes, 2-/3-/4-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector
		QD75MH1	(Note 1)	1 axis, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector, with SSCNET Ⅲ connectivity
	With SSCNET	QD75MH2	(Note 1)	2 axes, 2-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector, with SSCNET Ⅲ connectivity
	Ⅲ connectivity	QD75MH4	(Note 1)	4 axes, 2-/3-/4-axis linear interpolation, 2-axis circular interpolation, control unit: mm, inch, degree, pulse, no. of positioning data: 600/axis, 40-pin connector, with SSCNET Ⅲ connectivity
		QD74MH8		8 axes, control unit: pulse, no. of positioning data: 32/axis, with SSCNET Ⅲ connectivity
		QD74MH16		16 axes, control unit: pulse, no. of positioning data: 32/axis, with SSCNET Ⅲ connectivity
	Open collector output with built-in counter function	QD72P3C3	(Note 2)	Positioning: 3 axes, control unit: pulse, no. of positioning data: 1/axis, max. output pulse: 100 kpps, counter: 3 channels, 100 kpps, count input signal: 5/24 V DC, 40-pin connector

Note 1) A connector is not provided. The A6CON1/A6CON2/A6CON3/A6CON4 connector must be ordered separately. Note 2) A connector is not provided. The A6CON1/A6CON2/A6CON4 connector must be ordered separately.

Information module

Pro	duct	Model	Outline
MES interface	•	QJ71MES96	MES interface module *MX MESInterface and CompactFlash card are required.
		GT05-MEM-128MC	128 MB CompactFlash card
	Ontion	GT05-MEM-256MC	256 MB CompactFlash card
	Option	QD81MEM-512MBC	512 MB CompactFlash card
		QD81MEM-1GBC	1 GB CompactFlash card
High-Speed D	ata Logger	QD81DL96	High-Speed Data Logger module *CompactFlash card are required
		QD81MEM-512MBC	512 MB CompactFlash card
		QD81MEM-1GBC	1 GB CompactFlash card
	Option	QD81MEM-2GBC	2 GB CompactFlash card
		QD81MEM-4GBC	4 GB CompactFlash card
		QD81MEM-8GBC	8 GB CompactFlash card
		QJ71E71-100	10BASE-T/100BASE-TX
Ethernet		QJ71E71-B2	10BASE2
		QJ71E71-B5	10BASE5
		QJ71C24N	RS-232: 1 channel, RS-422/485: 1 channel, total transmission speed of 2 channels: 230.4 kbps
Serial commun	nication	QJ71C24N-R2	RS-232: 2 channels, total transmission speed of 2 channels: 230.4 kbps
		QJ71C24N-R4	RS-422/485: 2 channels, total transmission speed of 2 channels: 230.4 kbps
		QD51	BASIC program execution module, RS-232: 2 channels
Intelligent con	nmunication	QD51-R24	BASIC program execution module, RS-232: 1 channel, RS-422/485: 1 channel
mengent communication		SW1IVD-AD51HP (Note 1)	Software package for QD51, AD51H-S3, and A1SD51S

Note 1) The program is run in Windows® command prompt.

Control network module

Control fiet	work illoud	ile .	
CC-Link IE Co	ontroller	QJ71GP21-SX	Multi-mode fiber optic cable, dual loop, controller network (control/normal station)
Network		QJ71GP21S-SX	Multi-mode fiber optic cable, dual loop, controller network (control/normal station), with external power supply function
		QJ71LP21-25	SI/QSI/H-PCF/ broadband H-PCF fiber optic cable, dual loop, controller network (control/normal station) or remote I/O network (remote mater station)
	Optical loop (SI)	QJ71LP21S-25	SI/QSI/H-PCF/ broadband H-PCF fiber optic cable, dual loop, controller network (control/normal station) or remote I/O network (remote mater station), with external power supply function
		QJ72LP25-25	SI/QSI/H-PCF/ broadband H-PCF fiber optic cable, dual loop, remote I/O network (remote I/O station)
MELSECNET/H	Optical	QJ71LP21G	GI-50/125 fiber optic cable, dual loop, controller network (control/normal station) or remote I/O network (remote master station)
	loop (GI)	QJ72LP25G	GI-50/125 fiber optic cable, dual loop, remote I/O network (remote I/O station)
	Coaxial	QJ71BR11	3C-2V/5C-2V coaxial cable, single bus, controller network (control/normal station) or remote I/O network (remote master station)
	bus	QJ72BR15	3C-2V/5C-2V coaxial cable, single bus, remote I/O network (remote I/O station)
	Twist bus	QJ71NT11B	Twisted pair cable, single bus, controller network (control/normal station)
CC-Link IE Fie	eld Network	QJ71GF11-T2 NEW (Note 1)	Master/local station, CC-Link IE Field Network compatible
CC-Link		QJ61BT11N	Master/local station, CC-Link Ver. 2 compatible
CC-Link/LT		QJ61CL12	Master station
		QJ71FL71-T-F01	10BASE-T, 100BASE-TX
	Ver. 2.00	QJ71FL71-B2-F01	10BASE2
FL-net		QJ71FL71-B5-F01	10BASE5
(OPCN-2)		QJ71FL71-T	10BASE-T
	Ver. 1.00	QJ71FL71-B2	10BASE2
		QJ71FL71-B5	10BASE5
AS-i		QJ71AS92	Master station, AS-Interface Specification Version 2.11 compatible

Note 1) Supported by Universal model CPUs whose (first five serial number digits are 12012 or later).

GX Works2 version 1.25B or later is required for configuration and diagnosis functions.

Replacement support MELSEC-A/QnA transition products

Product Model			Outline				
	Main base	Q35BL	(Note 1)	5 slots. Power supply module installation required. For Q Series large input/output module installation			
	Main base	Q38BL	(Note 1)	8 slots. Power supply module installation required. For Q Series large input/output module installation			
	Extension base	Q65BL	(Note 1)	5 slots. Power supply module installation required. For Q Series large input/output module installation			
Q Large base		Q68BL	(Note 1)	8 slots. Power supply module installation required. For Q Series large input/output module installation			
		Q55BL	(Note 1)	5 slots. Power supply module installation not required. For Q Series large input/output module installation			
	Large blank cover	QG69L	(Note 1)	For gap adjustment when a previous Q Series module is installed on the Q large base			
		QX11L	(Note 1)	For replacement of "A" large module "AX11". 32 points, 100 to 120 V AC, response time: 25 ms, 32 points/common, 38-point terminal block			
	Input	QX21L NEW	(Note 1)	For replacement of "A" large module "AX21". 32 points, 200 to 240 V AC, response time: 25 ms, 32 points/common, 38-point terminal block			
Q Large I/O	Output	QY11AL NEW	(Note 1)	For replacement of "A" large module "AY10A, AY11A". 16 points, 24 V DC/240 V AC, 2 A/point; 16 A/all points, all-point independent contacts, response time: 12 ms, 38-point terminal block			
		QY13L	(Note 1)	For replacement of "A" large module "AY13". 32 points, 24 V DC/240 V AC, 2 A/point; 5 A/common, 8 points/common, response time: 12 ms, 38-point terminal block			
		QY23L	(Note 1)	For replacement of "A" large module "AY23". 32 points, 100 to 240 V AC; 0.6 A/point, 2.4 A/common, 8 points/common, response time: 1 ms + 0.5 cycle, 38-point terminal block			
		QD62-H01	(Note 2)	For replacement of "A" large module "AD61". 2 channels, 50 kpps, count input signal: 5/12/24 V DC, external input: 5/12/24 V DC, coincidence output: transistor (sync), 12/24 V DC, 0.5 A/point; 2 A/common			
High Speed Co	bunter	QD62-H02	(Note 2)	For replacement of "A" large module "AD61-S1". 2 channels, 10 kpps, count input signal: 5/12/24 V DC, external input: 5/12/24 V DC, coincidence output: transistor (sync), 12/24 V DC, 0.5 A/point; 2 A/common			
		QA1S65B	(Note 3)	5 slots. Requires AnS series power supply module installation. For AnS series module installation			
Extension	AnS series	QA1S68B	(Note 3)	8 slots. Requires AnS series power supply module installation. For AnS series module installation			
base	A series	QA65B	(Note 3)	5 slots. Requires A series power supply module installation. For A series module installation			
	A series	QA68B	(Note 3)	8 slots. Requires A series power supply module installation. For A series module installation			
For MELSECN	ET (II) local	A1SJ71AP23Q	(Note 3)	Optic cable, duplex loop, MELSECNET (II) local station			
station		A1SJ71AR23Q	(Note 3)	3C-2V/5C-2V coaxial cable, duplex loop, MELSECNET (II) local station			
For MELSECN station	For MELSECNET/B local station		(Note 3)	Twisted pair cable, single bus, MELSECNET/B local station			

Note 1) Only supported only by High Performance QCPU and Universal QCPU (Excluding Q00UJCPU).

Note 2) A connector is not provided. Please order one of the following separately: A6CON1/A6CON2/A6CON3/A6CON4

Note 3) Only supported only by High Performance model QCPU.

PC interface board

Product		Model	Outline
CC Link IF on	ntroller network	Q80BD-J71GP21-SX	PCI bus/PCI-X bus, Japanese/English OS compatible, multi-mode fiber optic cable, dual loop, controller network (control/normal station)
CC-LITIK IE COI	itroller network	Q80BD-J71GP21S-SX	PCI bus/PCI-X bus, Japanese/English OS compatible, multi-mode fiber optic cable, dual loop, controller network (control/normal station), with external power supply function
	Optical loop (SI)	Q81BD-J71LP21-25	PCI Express bus, Japanese/English OS compatible, SI/QSI/H-PCF/broadband H-PCF fiber optic cable, dual loop, controller network (control/normal station)
		Q80BD-J71LP21-25	PCI bus, Japanese/English OS compatible, SI/QSI/H-PCF/broadband H-PCF fiber optic cable, dual loop, controller network (control/normal station)
MELSECNET/H (10)		Q80BD-J71LP21S-25	PCI bus, Japanese/English OS compatible, SI/QSI/H-PCF/broadband H-PCF fiber optic cable, dual loop, controller network (control/normal station), with external power supply function
	Optical loop (GI)	Q80BD-J71LP21G	PCI bus, Japanese/English OS compatible, GI-50/125 fiber optic cable, dual loop, controller network (control/normal station)
	Coaxial bus	Q80BD-J71BR11	PCI bus, Japanese/English OS compatible, 3C-2V/5C-2V coaxial cable, single bus, controller network (control/normal station)
CC-Link		Q81BD-J61BT11	PCI Express bus, Japanese/English OS compatible, master/local interface board, CC-Link Ver. 2 compatible
CG-LINK		Q80BD-J61BT11N	PCI bus, Japanese/English OS compatible, master/local interface board, CC-Link Ver. 2 compatible

Product List

MELSOFT GX Series

* For details regarding compatible CPU types, refer to the "Compatible CPUs" item.

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Draduet	Madal		Compatible CPU							
Product	Model Outline		Universal model QnU QnUD(E)		High Performance	Basic model	Process CPU	Redundant CPU		
GX Works2 ()	SW1DNC-GXW2-E	PLC engineering software (software with integrated functions including tools for programming, simulation and various module setting/monitoring)	•	●	model •	•	_	_		
OV D 1 **	SW8D5C-GPPW-E	MELSEC programmable controller programming software	•	(Note 1)	•	•	•	•		
GX Developer 🕕	SW8D5C-GPPW-EV	MELSEC programmable controller programming software (upgrade)	•	(Note 1)	•	•	•	•		
GY Simulator (Note 2)	SW7D5C-LLT-E	MELSEC programmable controller simulation software	•	(Note 1)	•	•	•	•		
GX Simulator (Note 2)	SW7D5C-LLT-EV	MELSEC programmable controller simulation software (upgrade)	•	(Note 1)	•	•	•	•		
GX Converter (Note 2)	SW0D5C-CNVW-E	Excel/text data converter	_	_	•	•	•	•		
GX Configurator-AD (Note 2)	SW2D5C-QADU-E	MELSEC-Q dedicated analog to digital conversion module setting/ monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-DA (Note 2)	SW2D5C-QDAU-E	MELSEC-Q dedicated digital to analog conversion module setting/ monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-SC (Note 2)	SW2D5C-QSCU-E	MELSEC-Q dedicated serial communication module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-CT (Note 2)	SW0D5C-QCTU-E	MELSEC-Q dedicated high-speed counter module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-TC (Note 2)	SW0D5C-QTCU-E	MELSEC-Q dedicated temperature control module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-TI (Note 2)	SW1D5C-QTIU-E	MELSEC-Q dedicated temperature input module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-FL (Note 2)	SW0D5C-QFLU-E	MELSEC-Q dedicated FL-net module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-PT (Note 2)	SW1D5C-QPTU-E	MELSEC-Q dedicated positioning module QD70 setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-AS (Note 2)	SW1D5C-QASU-E	MELSEC-Q dedicated AS-i master module setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Configurator-QP	SW2D5C-QD75P-E	MELSEC-Q dedicated positioning module QD75P/D/M setting/monitoring tool	•	(Note 1)	•	•	•	•		
GX Explorer	SW2D5C-EXP-E	Maintenance tool	_	_	•	•	(Note 3)	_		
GX RemoteService-I	SW2D5C-RAS-E	Remote access tool	_	_	•	•	(Note 3)	_		
GX Works	SW4D5C-QSET-E	A set of seven products: GX Developer, GX Simulator, GX Explorer, GX Configurator-AD, DA, SC, CT			(Not	e 4)				
	SW8D5C-GPPLLT-E	C-GPPLLT-E A set of three products: GX Developer, GX Simulator, GX Explorer		(Note 4)						

^{*}Contact your local Mitsubishi sales office or representative for the latest information about software versions and compatibility.

Note 1) Not compatible with Q50UDEHCPU, Q100UDEHCPU, and QJ71GF11-T2.

Note 2) Operates at GX Developer add-in software. GX Developer is required.

Note 3) Not compatible with Q02PHCPU and Q06PHCPU.

Note 4) For details regarding set-item compatible CPUs, refer to the compatible CPUs for the single products.

MELSOFT PX Series

* For details regarding compatible CPU types, refer to the "Compatible CPUs" item.

	Model	Outline	Compatible CPU					
Product			Universal model High		High	Basic		Redundant
			QnU	QnUD(E)	Performance model	model	CPU	CPU
PX Developer 🔱	SW1D5C-FBDQ-E	Process control FBD software package		_	_	-	•	•
PX Works	SW3D5C-FBDGPP-E	A set of six products: PX Developer, GX Developer, GX Configurator-AD, DA, CT, TI	(Note)					

Note) For details regarding set-item compatible CPUs, refer to the compatible CPUs for the single products.

MELSOFT MX Series

MX Component 🕩	SW3D5C-ACT-E	ActiveX library for communication	• • • • •		•	•
MX Sheet 🕩	SW1D5C-SHEET-E	Excel® communication support tool	• • • • •		•	
MX Works	SW1D5C-SHEETSET-E	A set of two products: MX Component, MX Sheet	(Note 1)			
MX MESInterface	SW1DNC-MESIF-E	MES interface module QJ71MES96 dedicated information linkage tool	(Note 2)			

Note 1) For details regarding set-item compatible CPUs, refer to the compatible CPUs for the single products. Note 2) Required when using the MES interface module.

MELSOFT iQ Works

		FA engineering software (Note)	
	SW1DNC-IQWK-E NEW (CD edition)	System management software "MELSOFT Navigator" Upstream design, tool for linkage to iQ Works products	
MELSOFT iQ Works	•	PLC engineering software "MELSOFT GX Works2" Tools for PLC programming, simulation and various module setting/monitoring	
	SW1DND-IQWK-E NEW	Motion controller engineering software "MELSOFT MT Works2" Total support tools for motion controller design and maintenance	
	(DVD edition)	Display screen creation software "MELSOFT GT Works3" Support tools for display screen creation	

Note) For details concerning compatible models for each software item, refer to the relevant product manuals.

Multiple licenses, additional licenses, and multiple license upgrades are available Multiple licenses and additional licenses are available. Multiple licenses are available.

Compatible CPUs

Item		Model
	QnU	Q00UJ, Q00U, Q01U, Q02U
Universal model QCPU	QnUD(E)	Q03UD(E), Q04UD(E)H, Q06UD(E)H, Q10UD(E)H, Q13UD(E)H, Q20UD(E)H, Q26UD(E)H, Q50UDEH, Q100UDEH
High Performance n	nodel QCPU	Q02, Q02H, Q06H, Q12H, Q25H
Basic model QCPU		Q00J, Q00, Q01
Process CPU		Q02PH, Q06PH, Q12PH, Q25PH
Redundant CPU		Q12PRH, Q25PRH

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